

# Building the Mu3e Experiment

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## Particle Physics 2025:

- All particles in the Standard Model discovered
- Very few lab measurements in tension with SM
- SM known to be incomplete: Dark matter, baryon asymmetry, gravity, hierarchy,...





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## Particle Physics 2025:

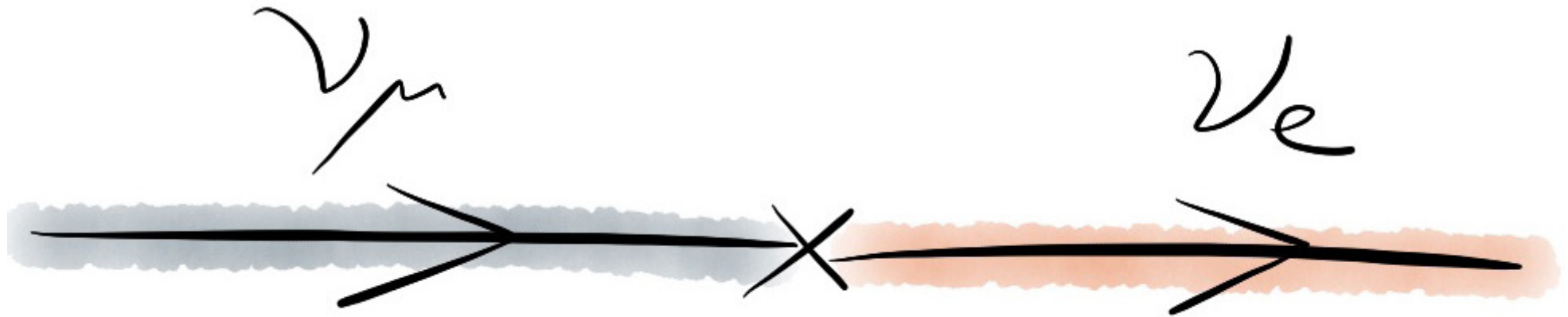
- All particles in the Standard Model discovered
- Very few lab measurements in tension with SM
- SM known to be incomplete: Dark matter, baryon asymmetry, gravity, hierarchy,...
- Where to look for new physics?
- Where do we see physics beyond the standard model already?





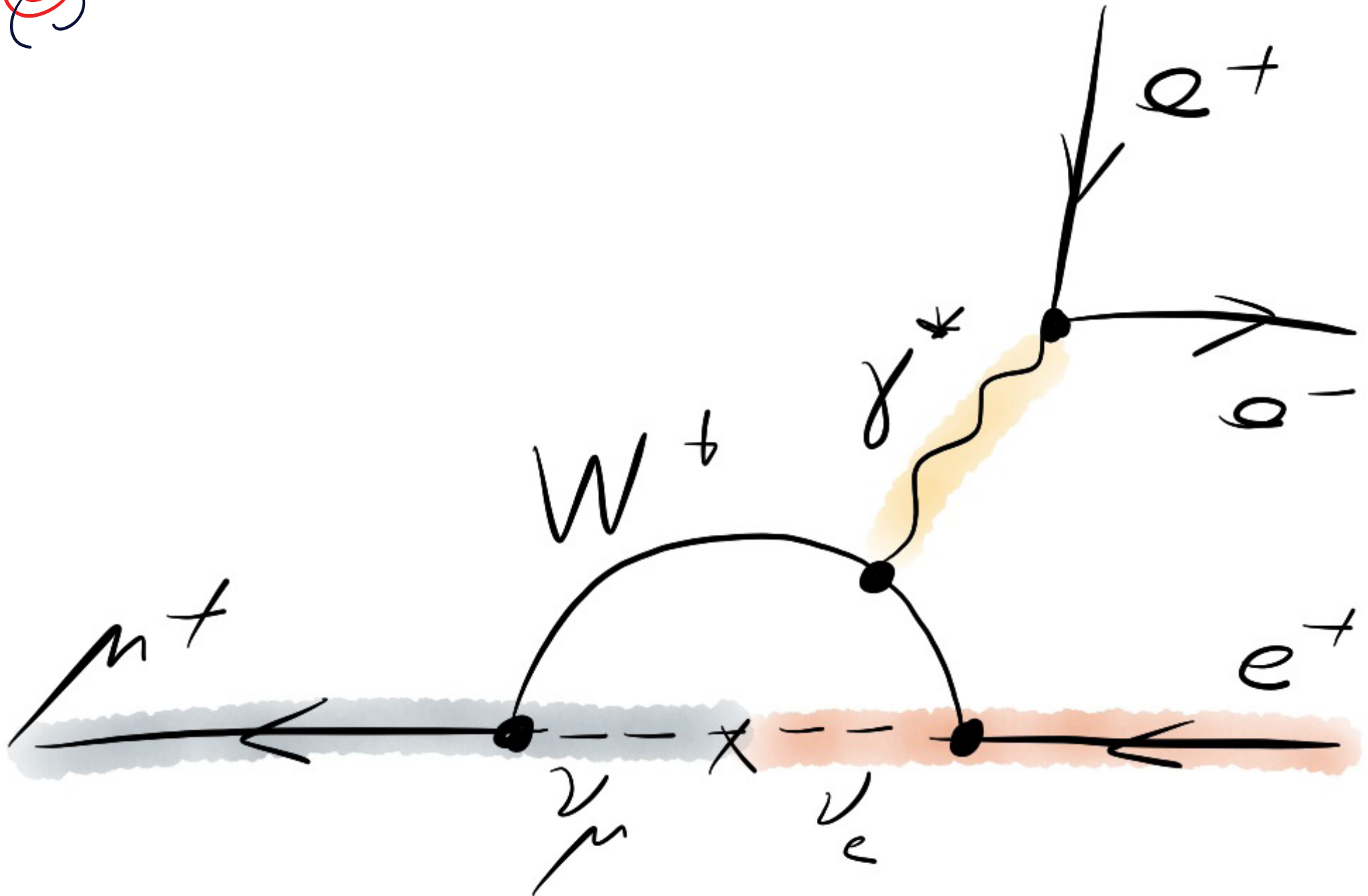


# Lepton Flavour Violation!





# Charged Lepton Flavour Violation?

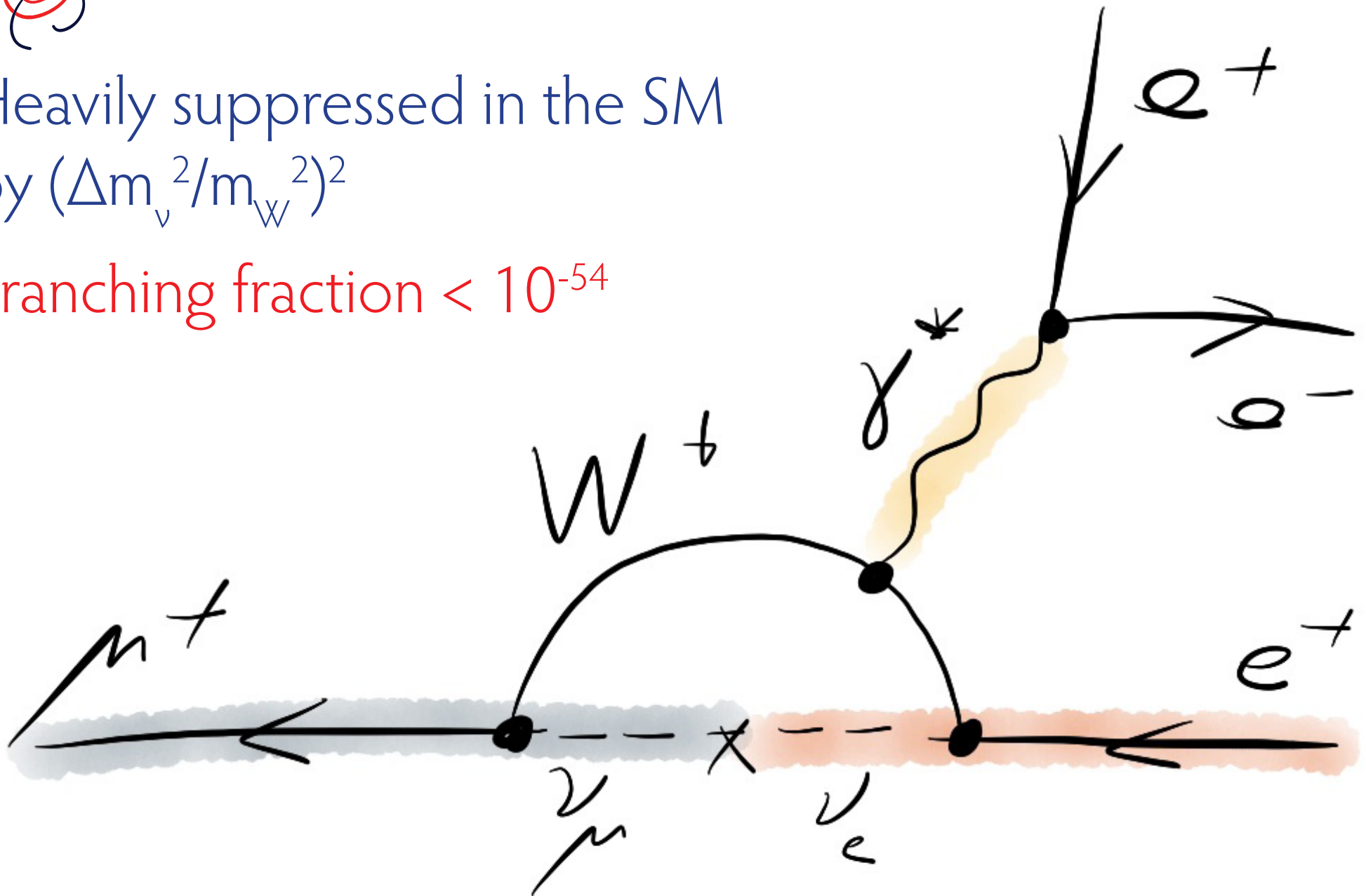




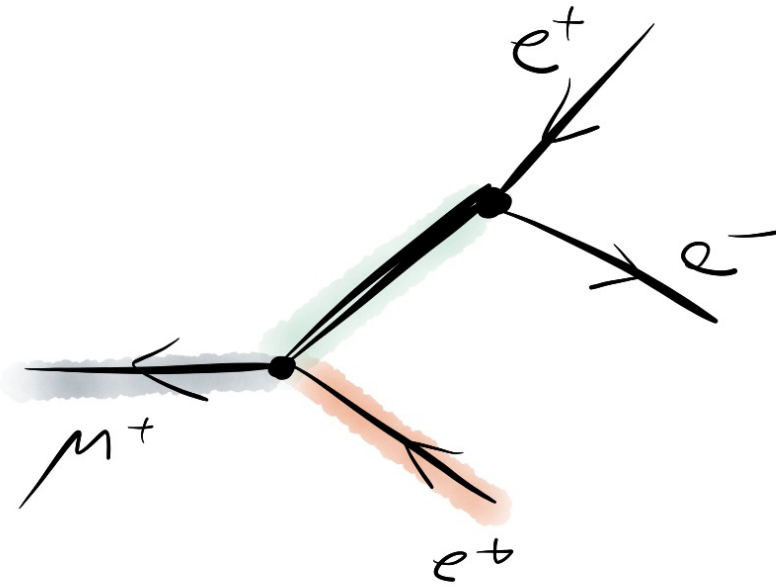
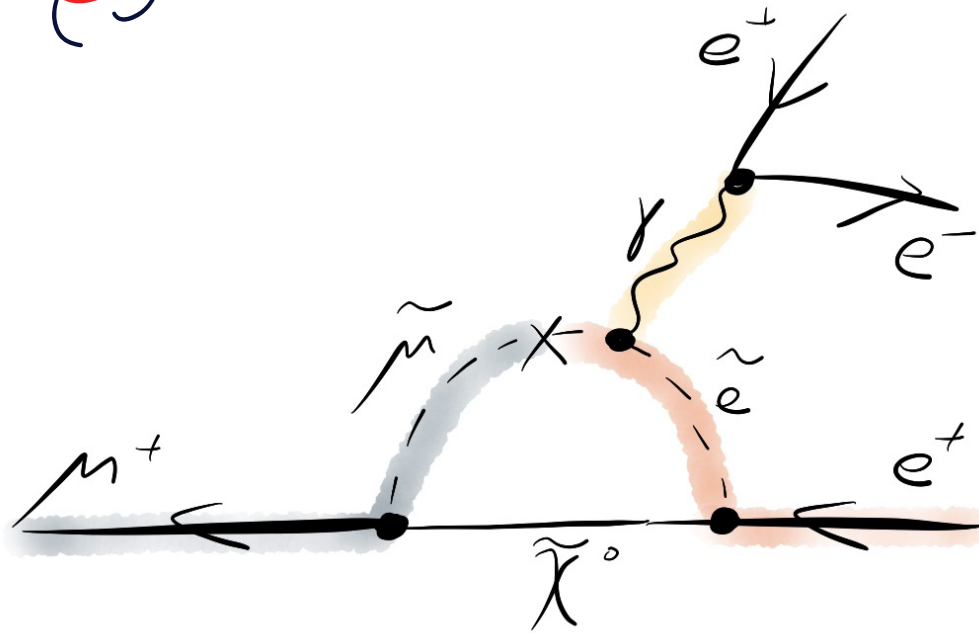
# Charged Lepton Flavour Violation?

Heavily suppressed in the SM  
by  $(\Delta m_\nu^2/m_W^2)^2$

Branching fraction  $< 10^{-54}$



# New physics in $\mu^+ \rightarrow e^+e^-e^+$



## Loop diagrams

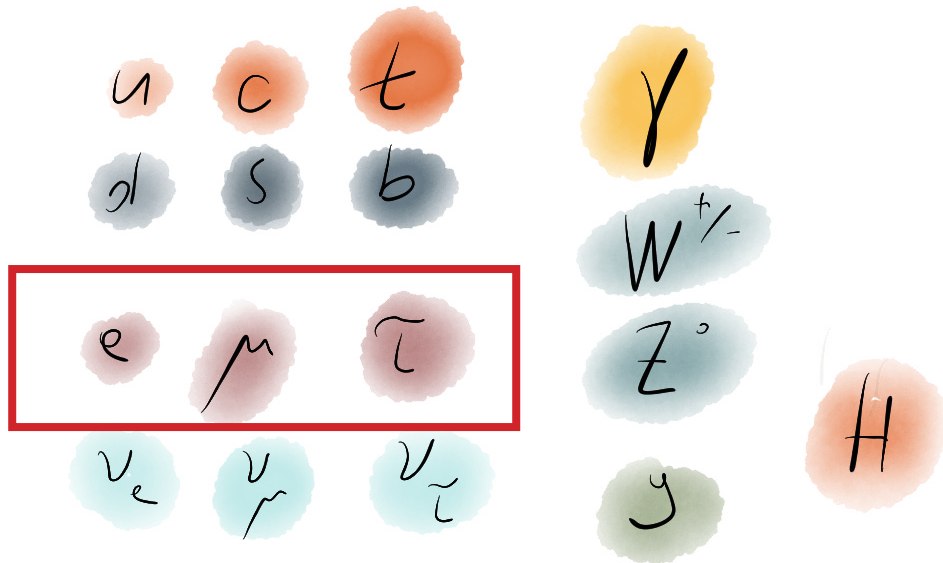
- Supersymmetry
- Little Higgs models
- Seesaw models
- GUT models (leptoquarks)
- and much more...

## Tree diagrams

- Higgs triplet model
- Extra heavy vector bosons ( $Z'$ )
- Extra dimensions (Kaluza-Klein tower)
- ...

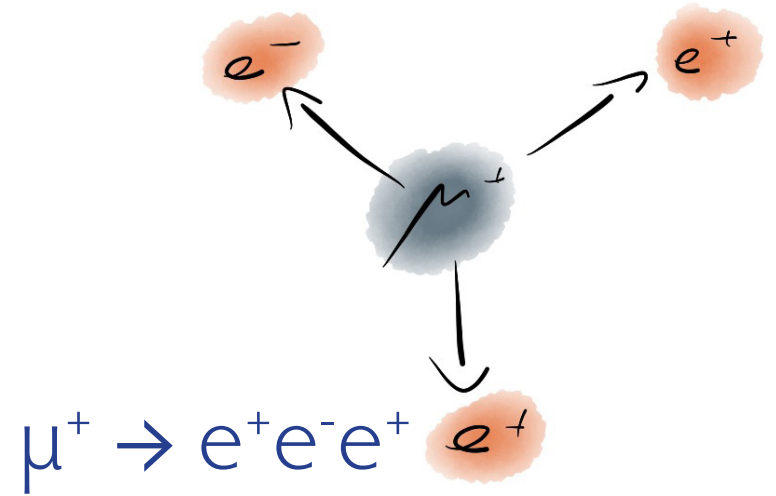
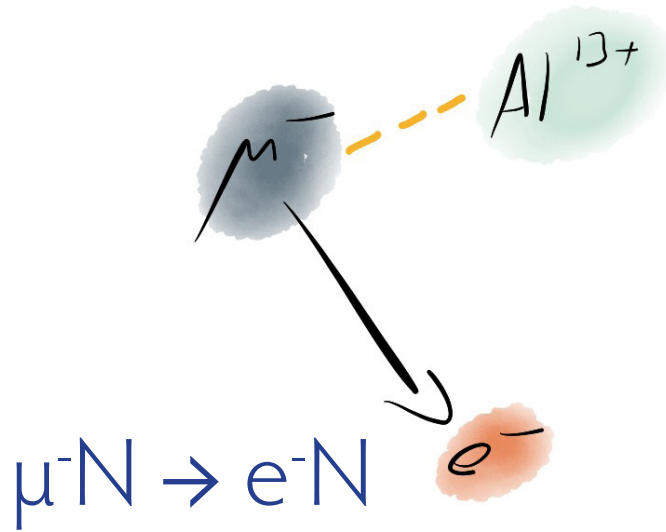
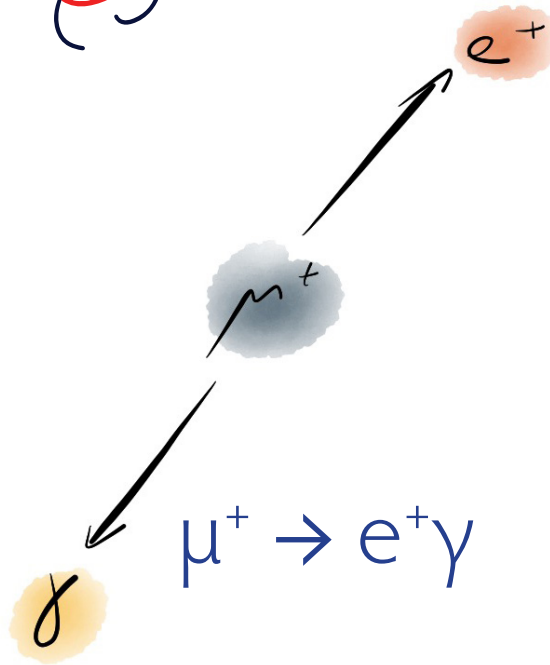


# Menu of charged Leptons



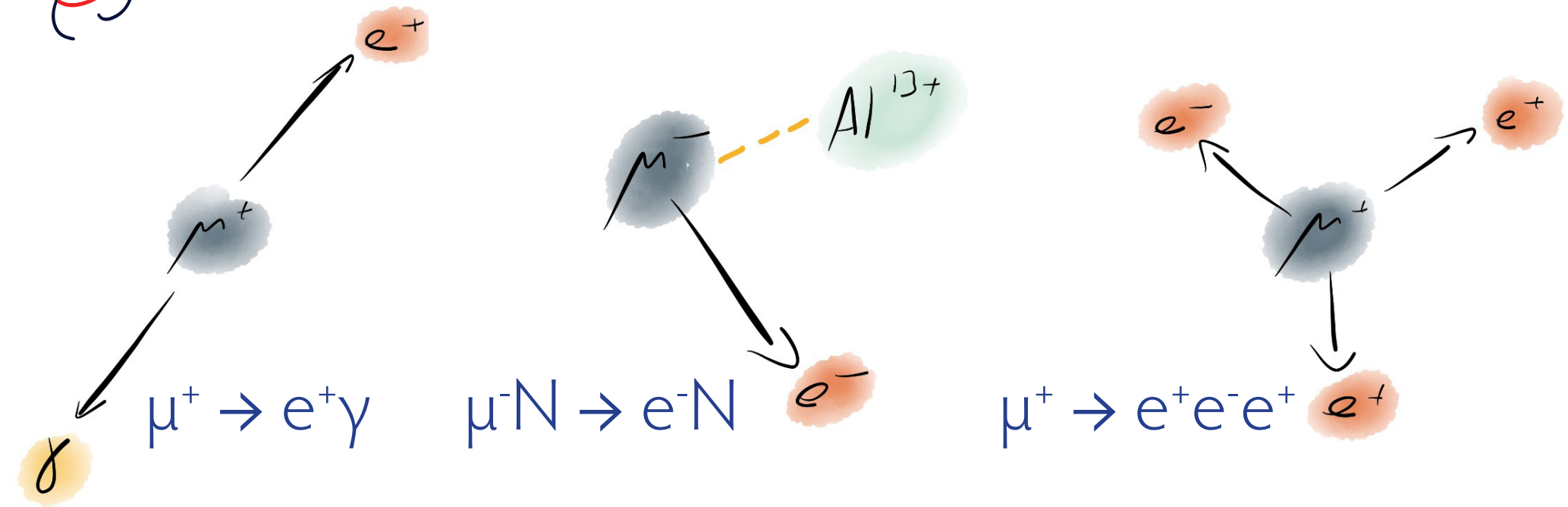
- Electrons are stable...
- New physics sensitivity (heavy new physics, very generic) scales with  $m_l^2$   
 $\tau$ 's are most sensitive
- But: Can produce about as many muons per second as taus in a year
- Muons lead the search for charged Lepton Flavour Violation

# LFV Muon Decays: Experimental Situation





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MEG/MEG II (PSI)

$$B(\mu^+ \rightarrow e^+ \gamma) < 3.1 \cdot 10^{-13}$$

(2024)

SINDRUM II (PSI)

$$B(\mu^- Au \rightarrow e^- Au) < 7 \cdot 10^{-13}$$

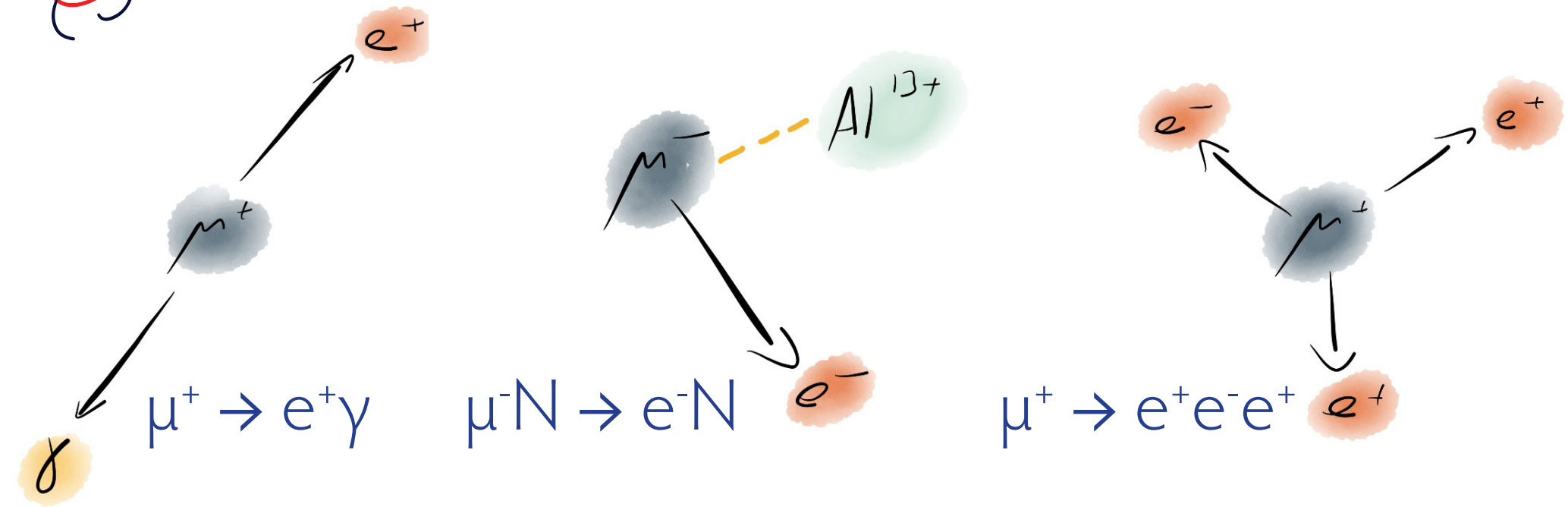
(2006)

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(1988)

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Mu2e/Comet

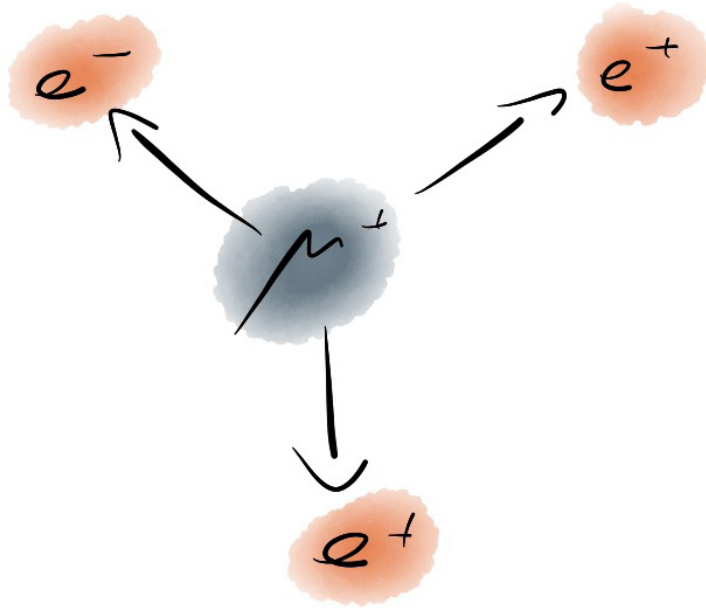
Mu3e





# The $\mu^+ \rightarrow e^+ e^- e^+$ Process: Requirements for an Experiment

# The signal

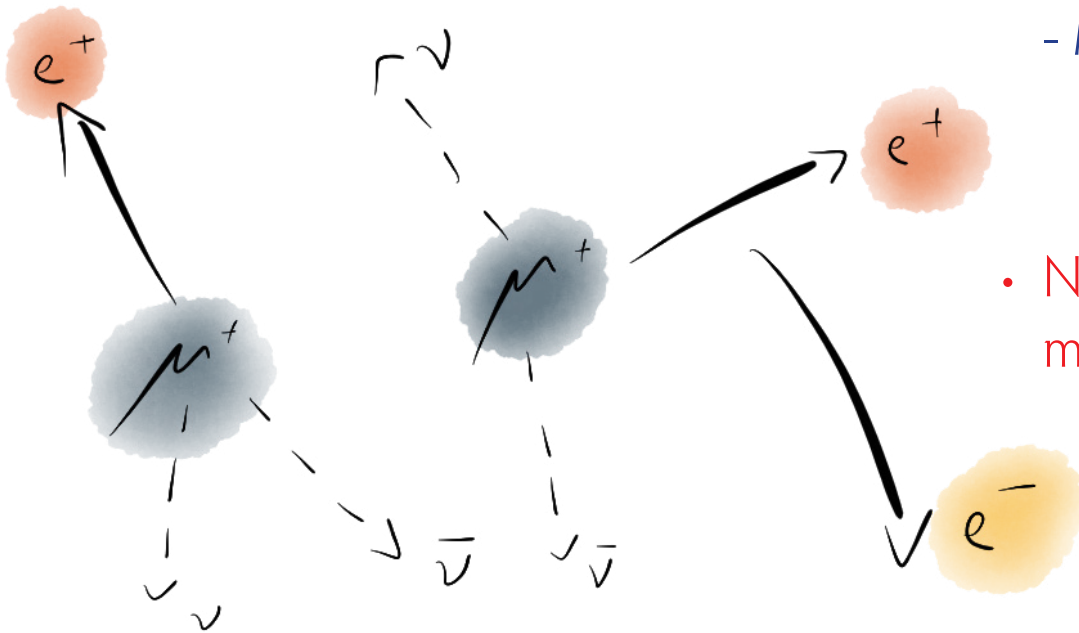


- $\mu^+ \rightarrow e^+e^-e^+$
- Two positrons, one electron
- From same vertex
- Same time
- Sum of 4-momenta corresponds to muon at rest
- Maximum momentum:  $\frac{1}{2} m_\mu = 53 \text{ MeV}/c$

# Accidental Background



- Combination of positrons from ordinary muon decay with electrons from:
  - photon conversion,
  - Bhabha scattering,
  - Mis-reconstruction



- Need very good timing, vertex and momentum resolution



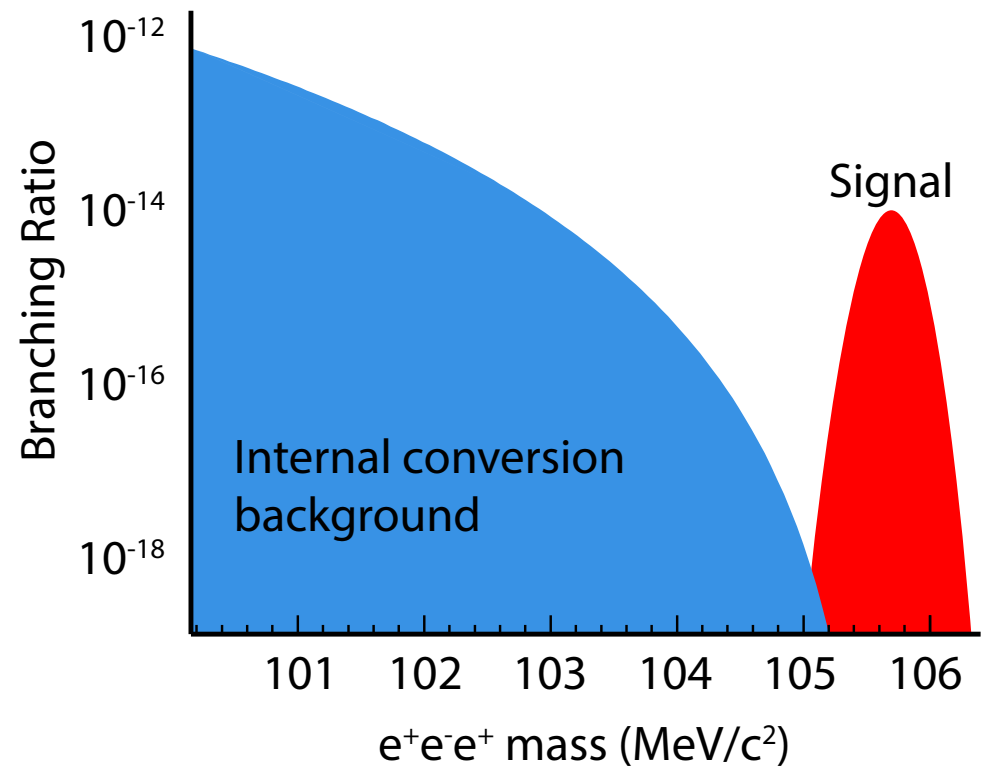
# Internal conversion background



- Allowed radiative decay with internal conversion:  

$$\mu^+ \rightarrow e^+e^-e^+\nu\bar{\nu}$$
- Only distinguishing feature:  
 Missing momentum carried by neutrinos

- Need excellent momentum resolution





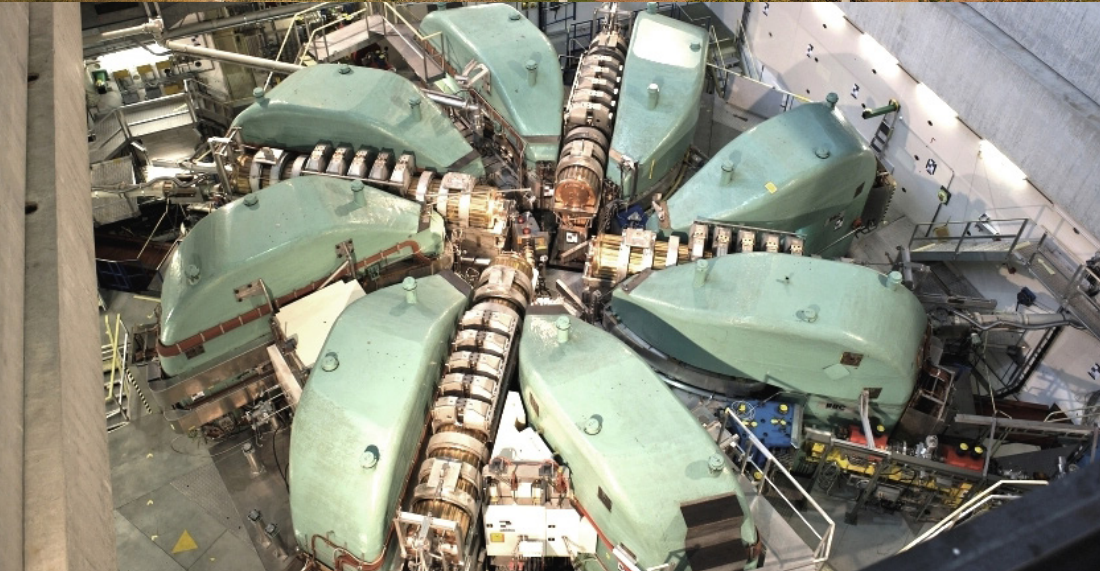
# Building the Mu3e Experiment

aiming for a branching ratio sensitivity of  $10^{-16}$

(few  $10^{-15}$  for the current first phase)



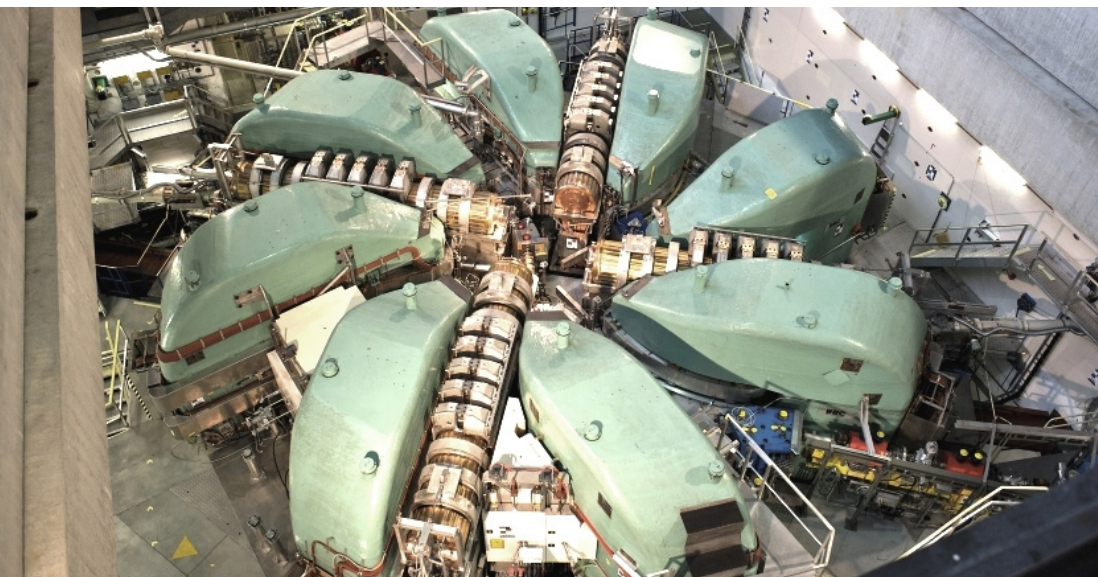
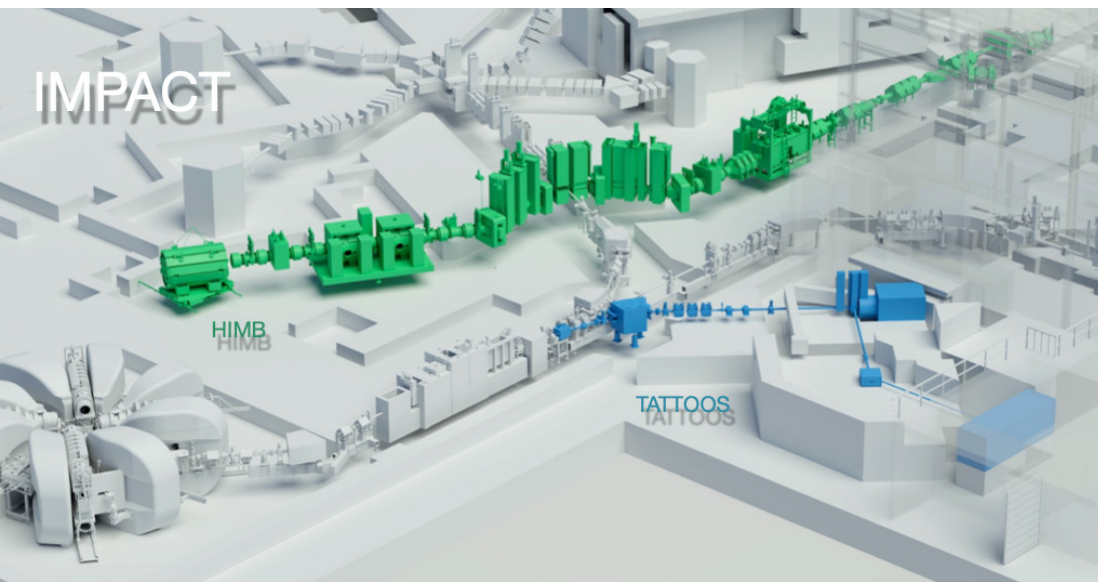
# Getting Muons



- Paul Scherrer Institute in Switzerland
- 1.4 MW, 590 MeV proton accelerator
- Carbon target, produce pions, decay to muons
- Currently: Up to  $10^8$  muons/s available: Mu3e Phase I



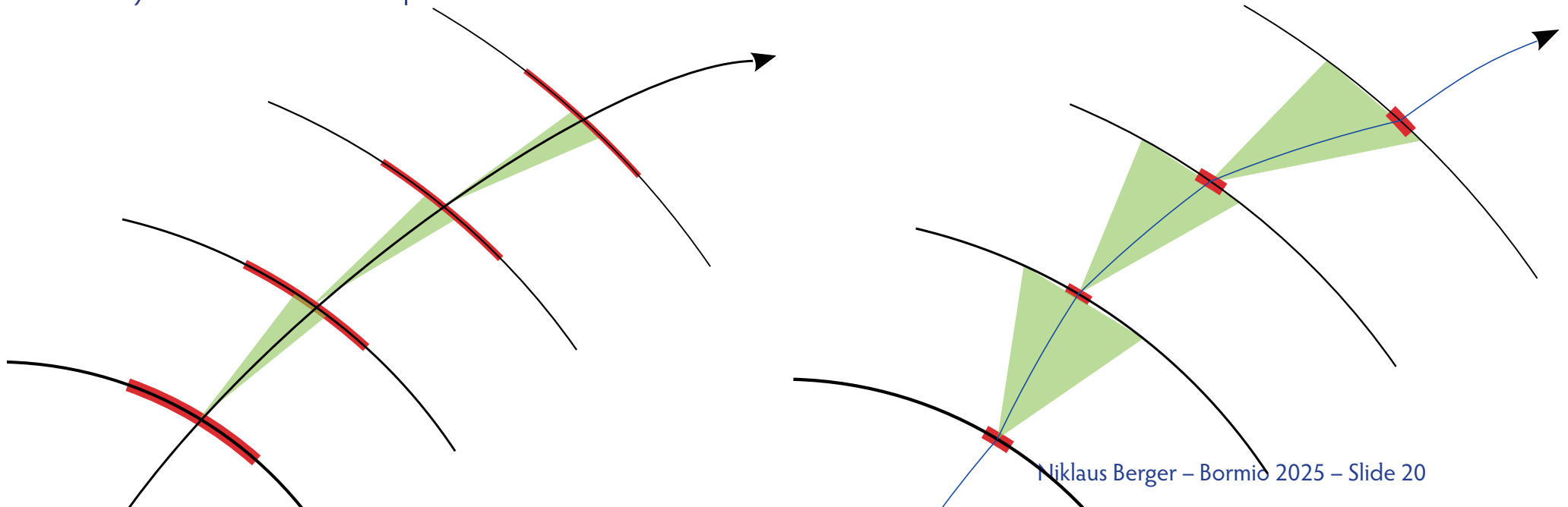
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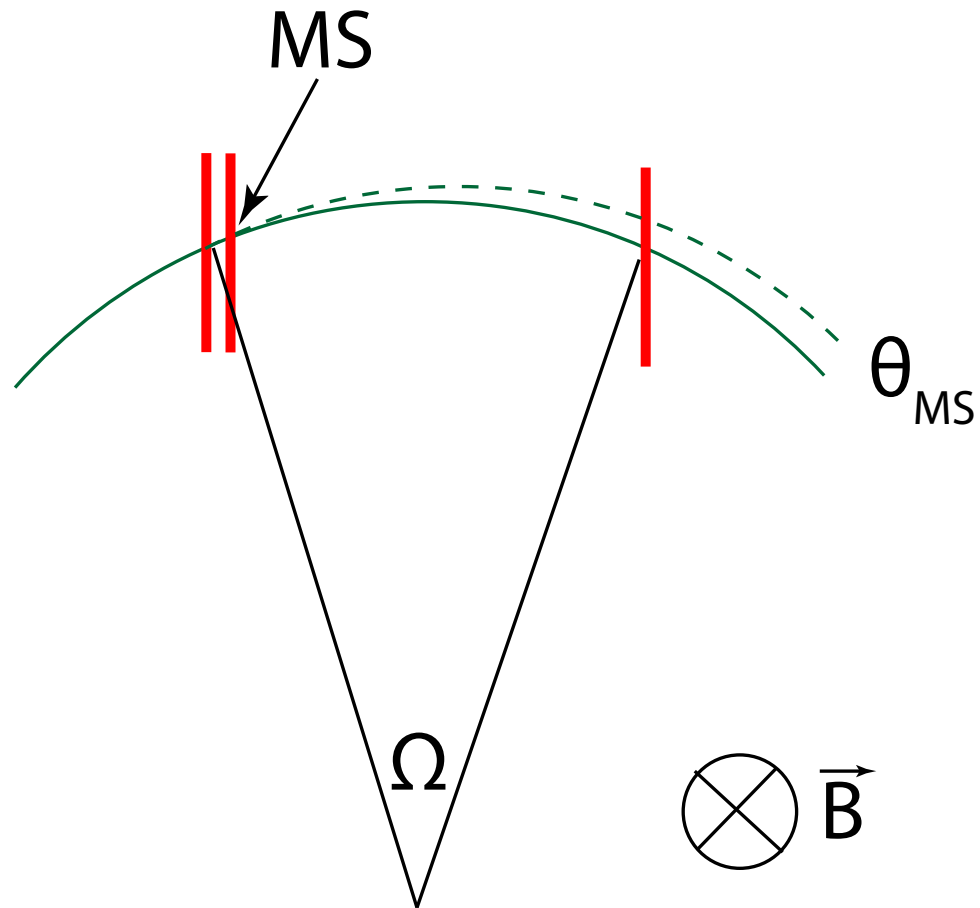
- Paul Scherrer Institute in Switzerland
- 1.4 MW, 590 MeV proton accelerator
- Carbon target, produce pions, decay to muons
- Currently: Up to  $10^8$  muons/s available: Mu3e Phase I
- Future (2027+): High-intensity muon beamline (HIMB) with up to  $10^{10}$  muons/s Mu3e Phase II
- Need to be able to stand these rates and get very good momentum resolution

# Momentum measurement in magnetic field

- Measure curvature in magnetic field
- High rates
- Want to get very close to the beam (vertexing)
- Gas detectors will not work
- Solid state detectors add material for every measurement point
- Momenta below 53 MeV
- Resolution is completely dominated by scattering in the detector
- Want few, extremely thin layers



# Momentum measurement



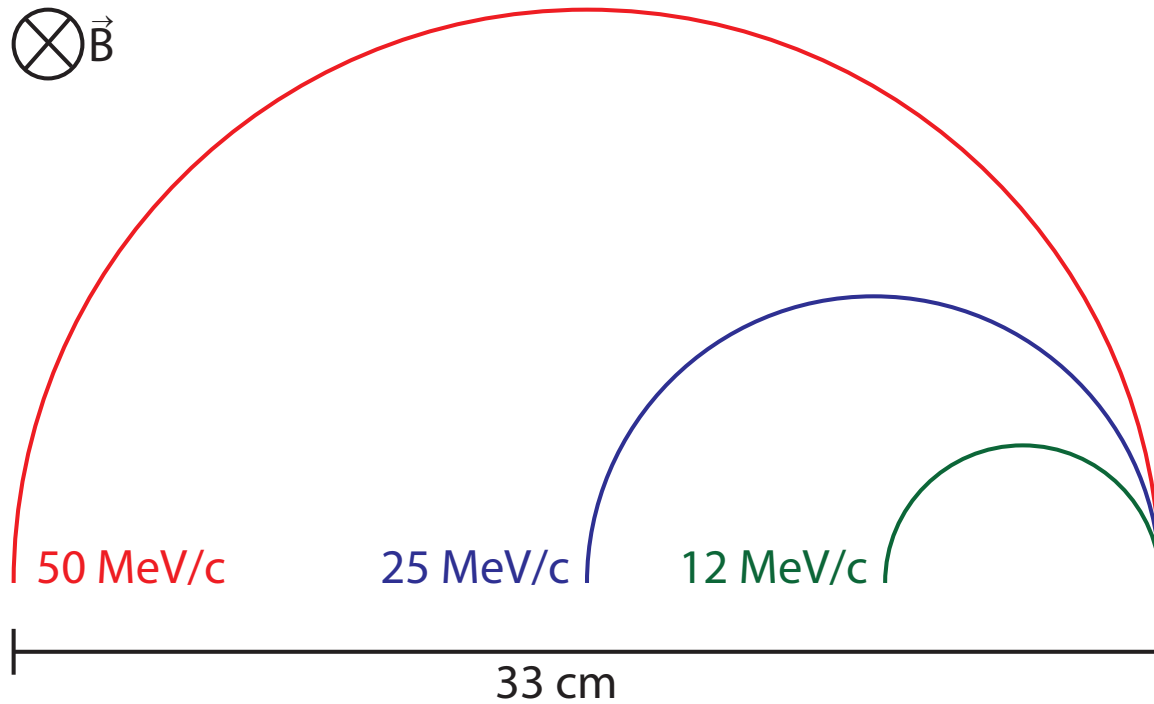
- 1 T magnetic field
- Resolution dominated by **multiple scattering**
- Momentum resolution to first order:

$$\sigma_{P/P} \sim \theta_{MS}/\Omega$$

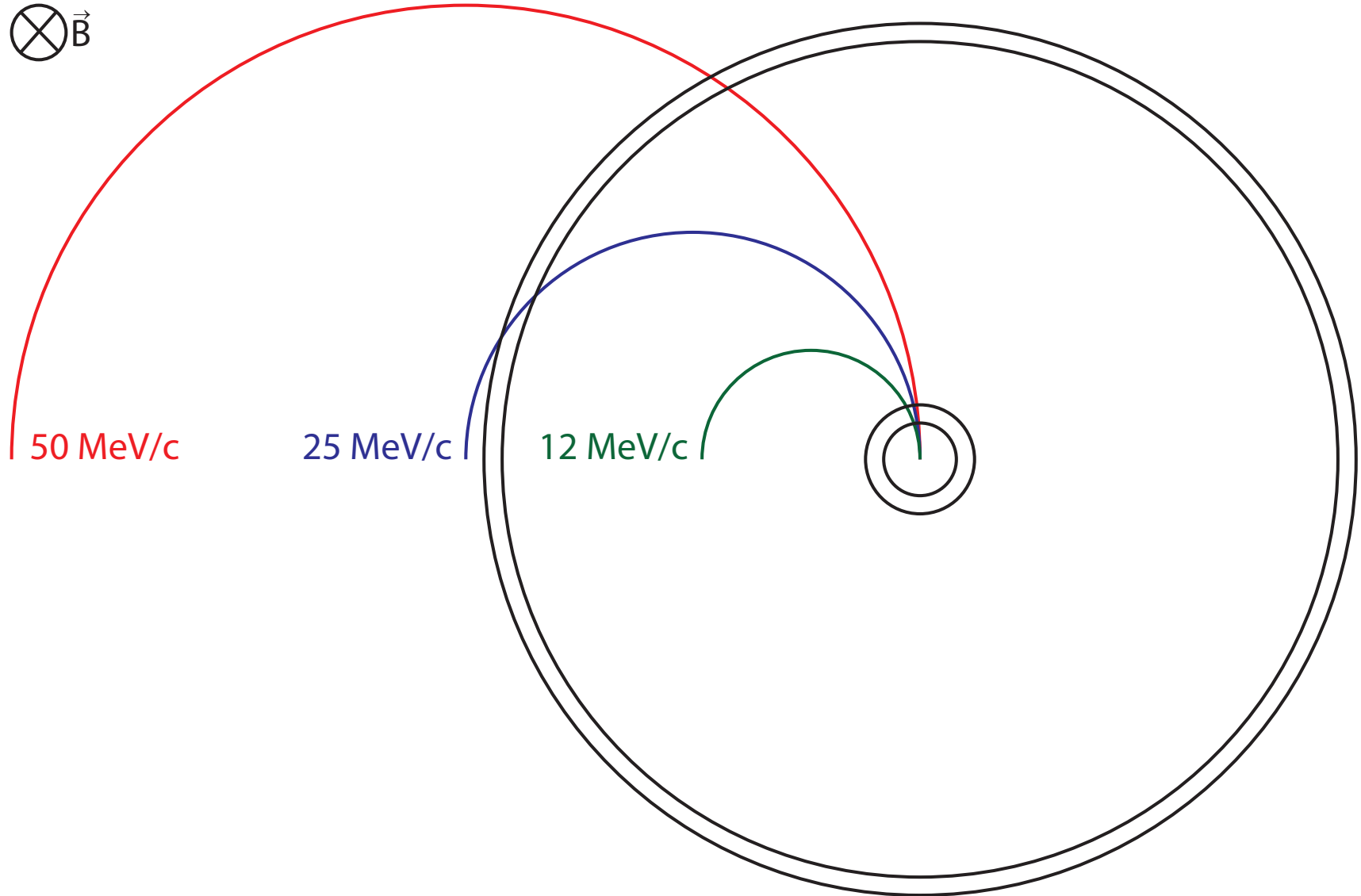
- Precision requires large lever arm (large bending angle  $\Omega$ ) and low multiple scattering  $\theta_{MS}$



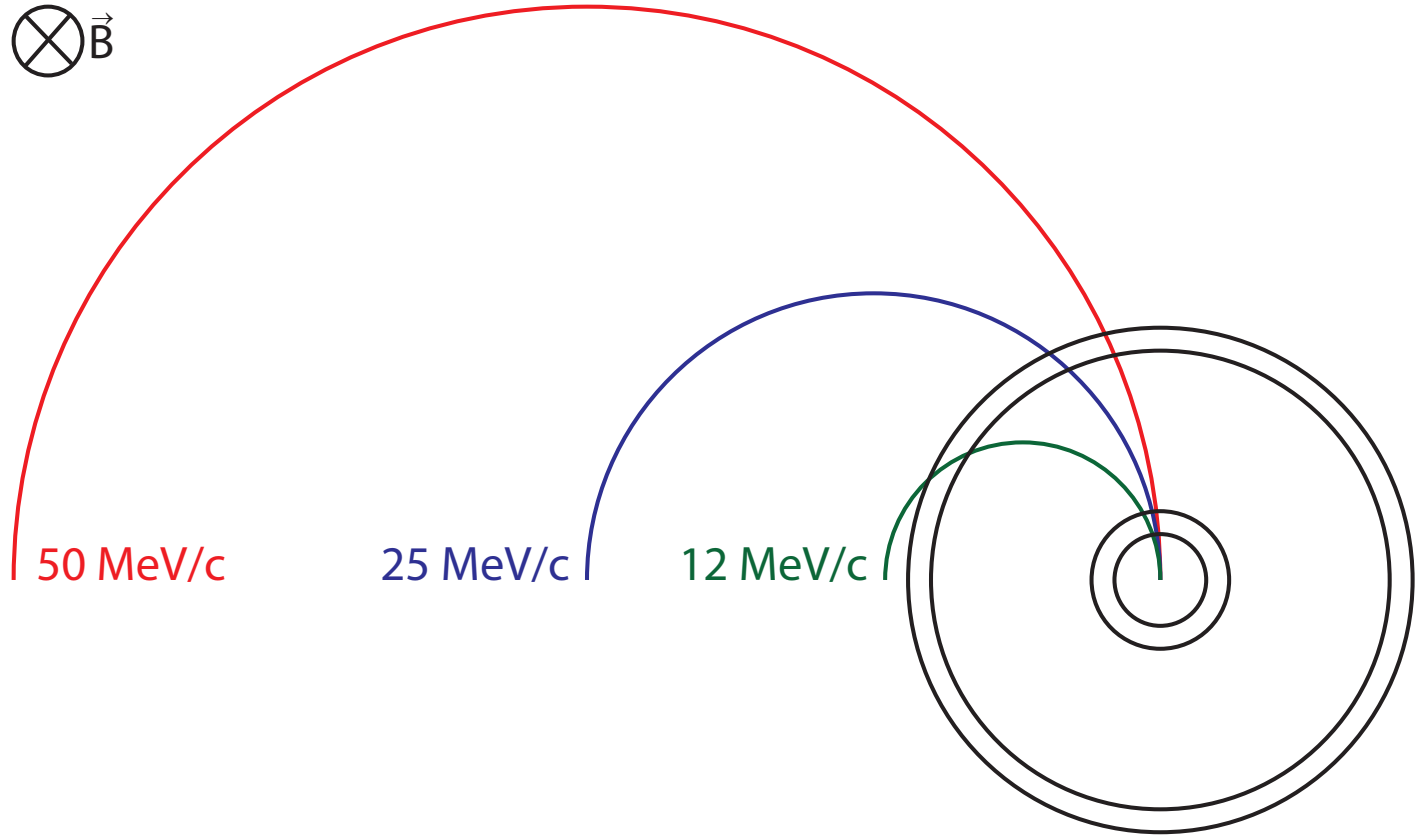
# Precision vs. Acceptance



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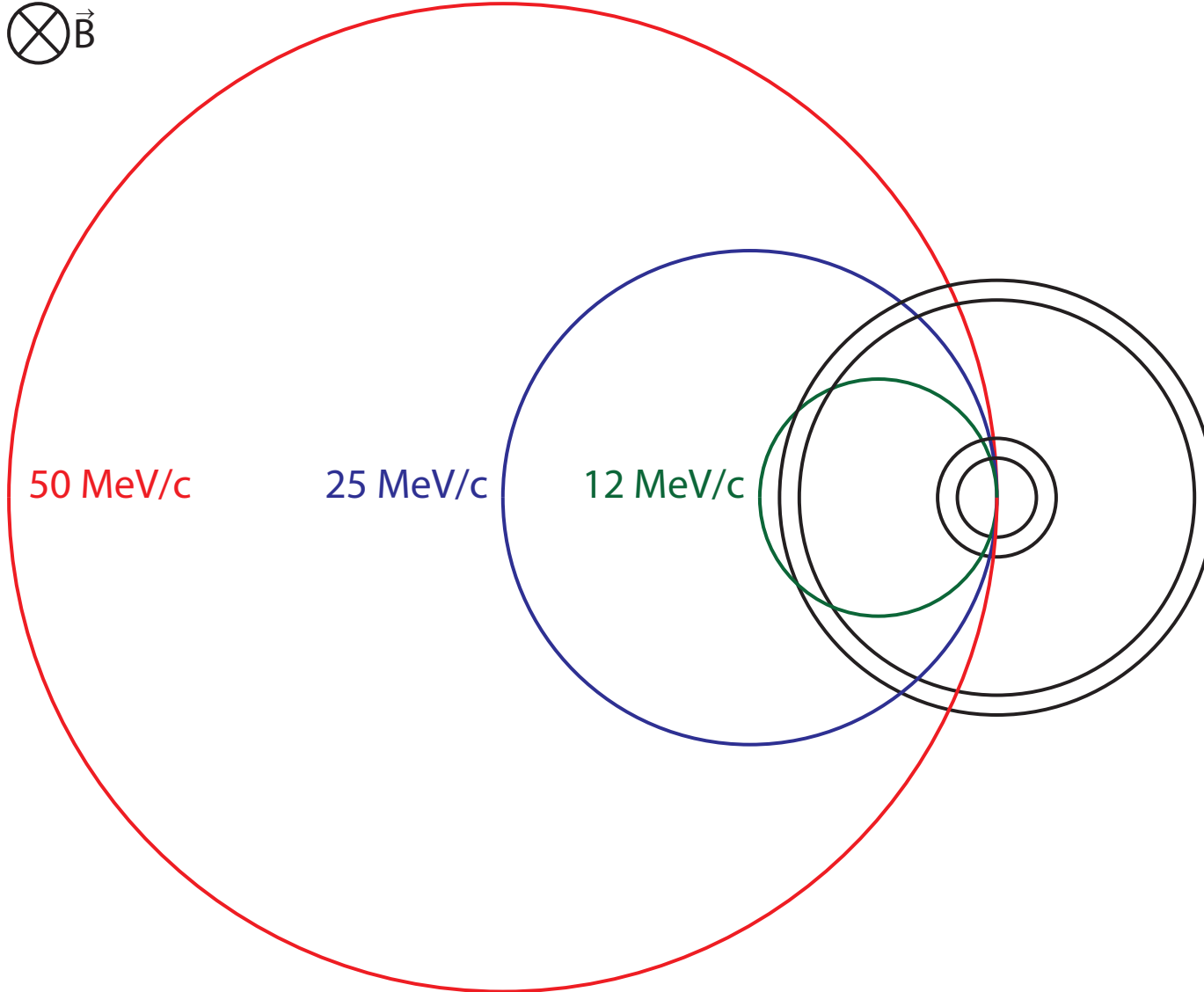


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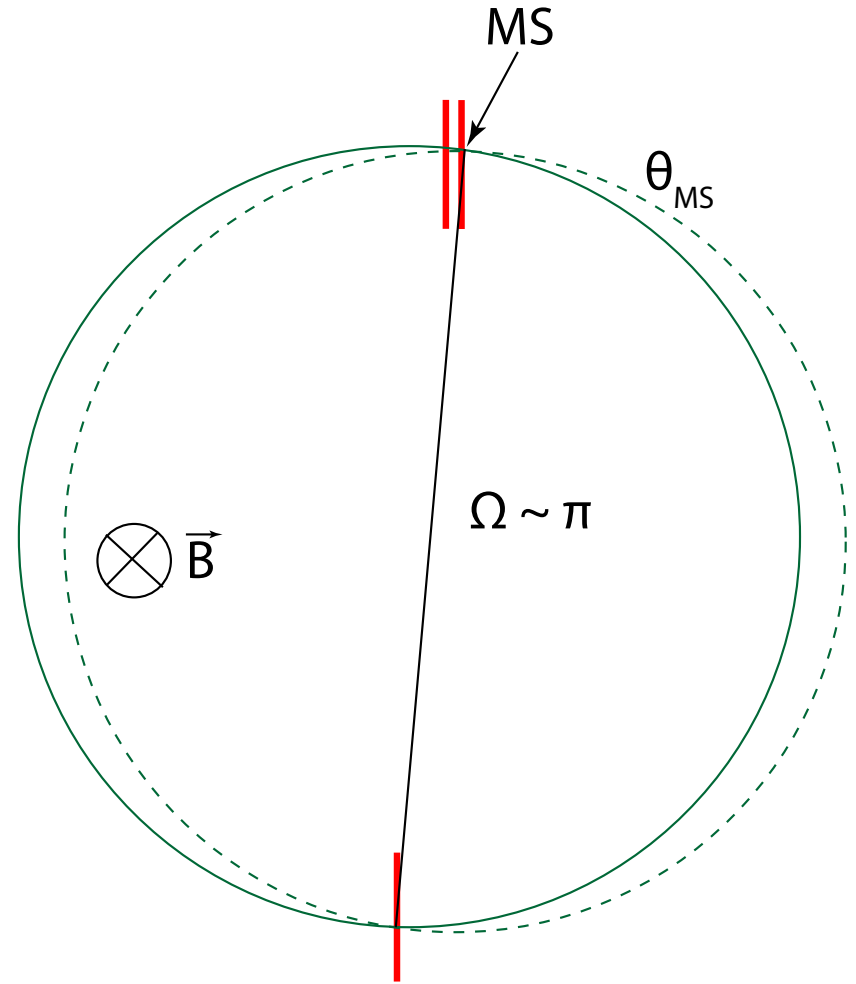
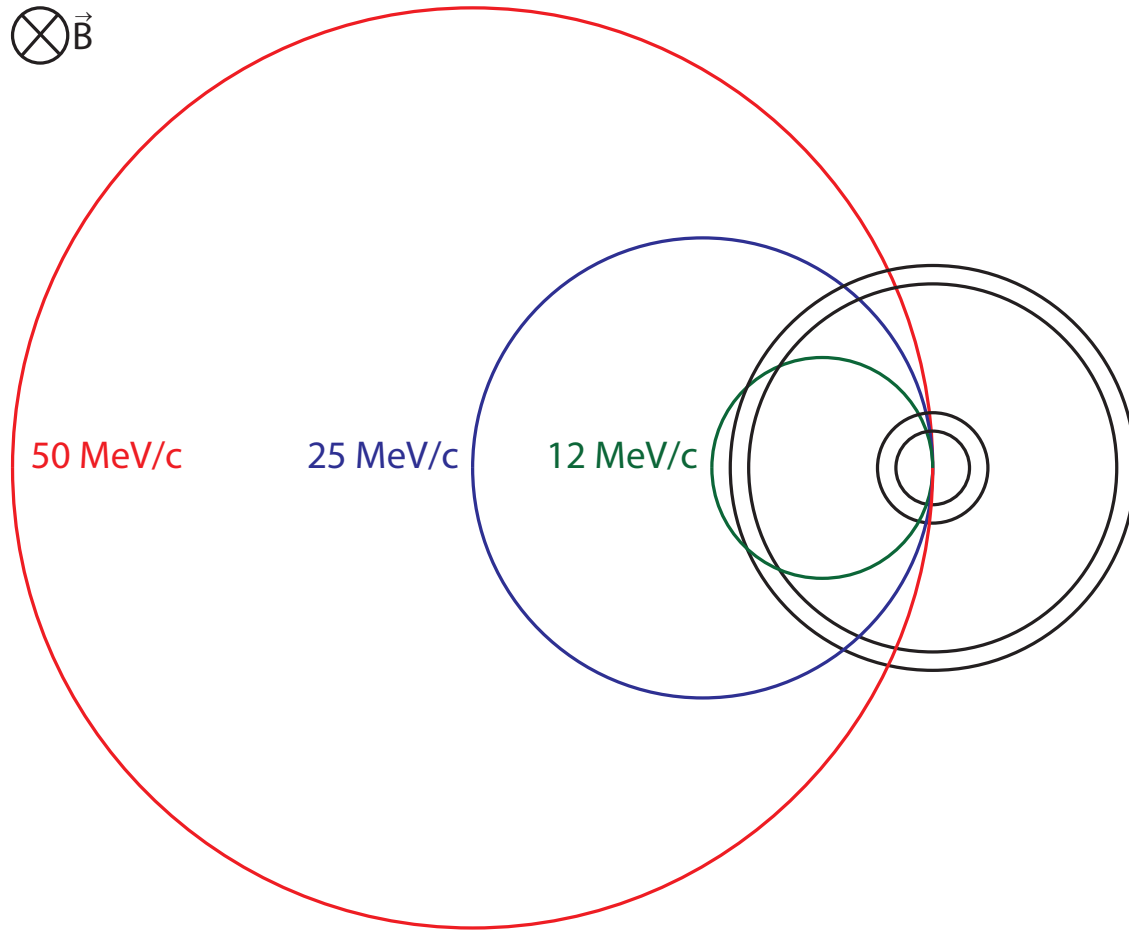


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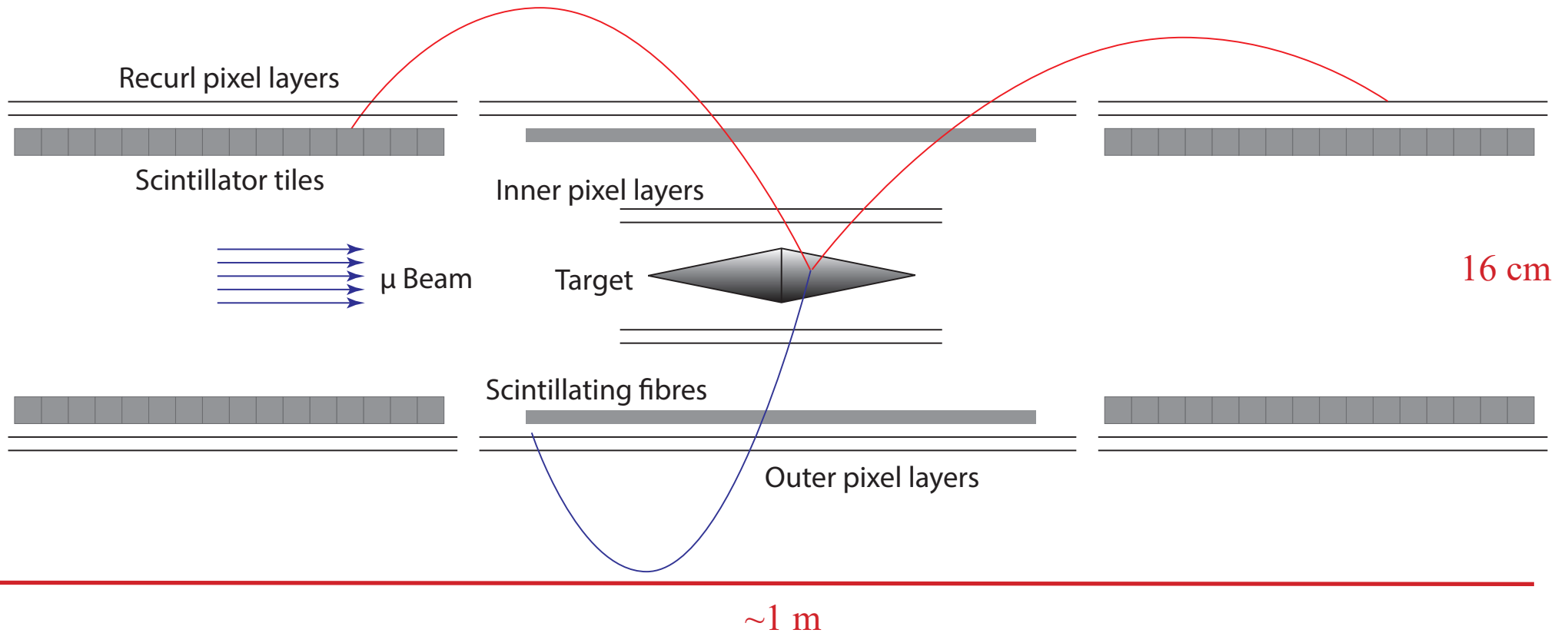


# Precision vs. Acceptance





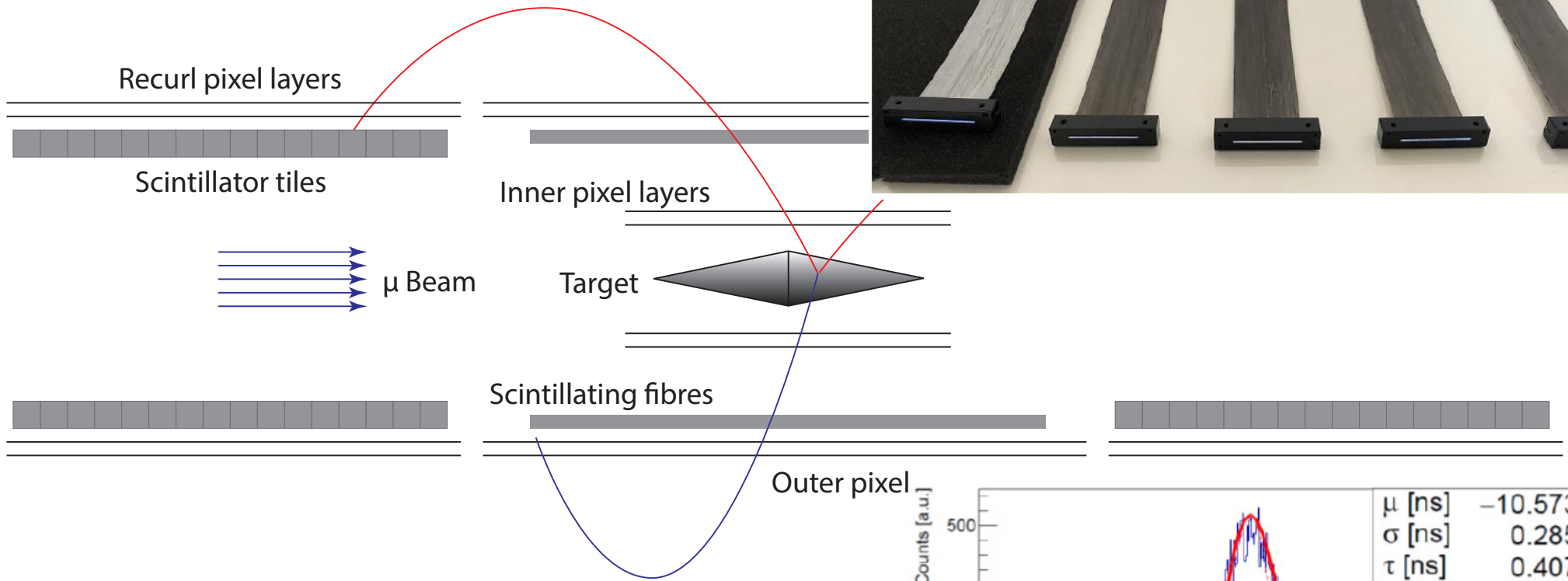
# Experiment concept



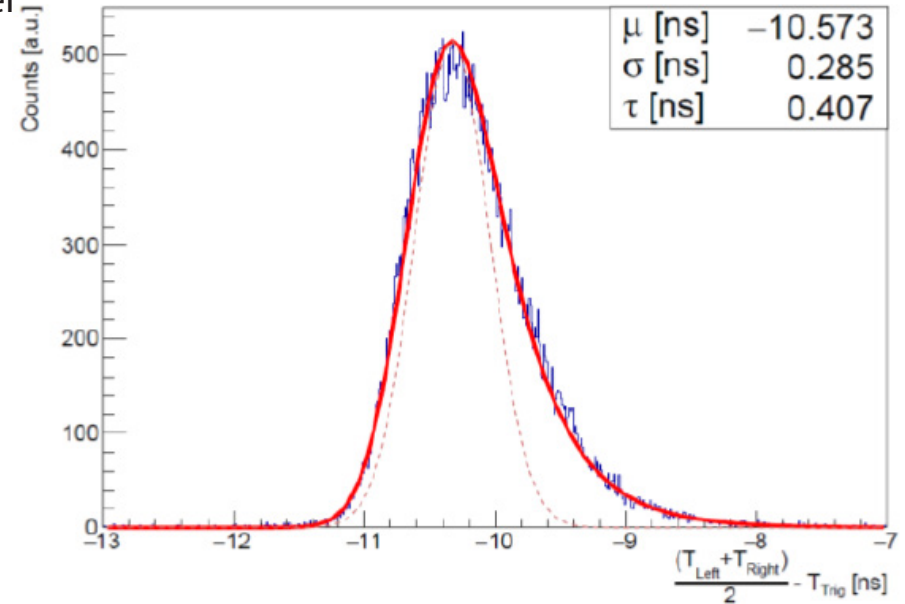
- 1 T magnetic field
- Hollow double-cone stopping target
- Pixels for momentum and vertexing
- Scintillating fibres and tiles for timing
- Measure tracks curling back in the field



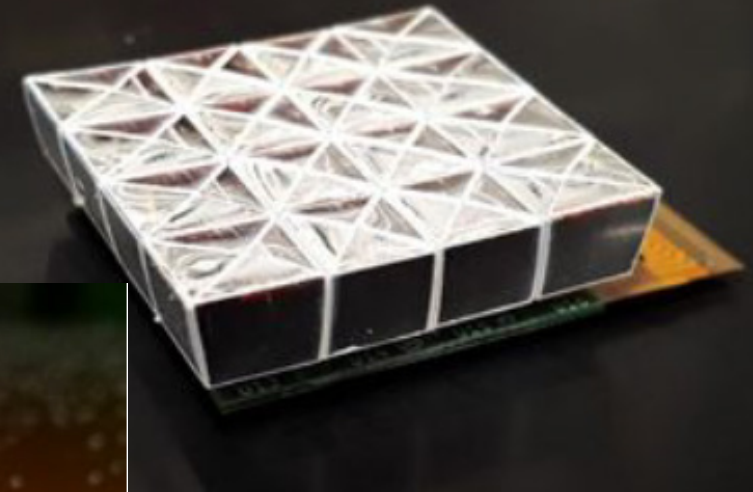
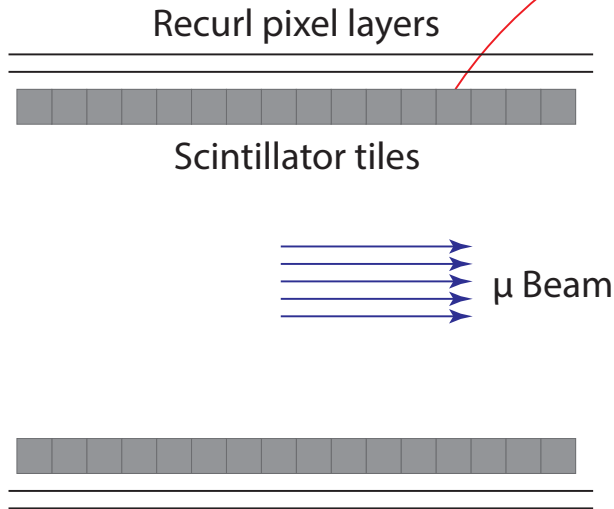
# Scintillating fibres



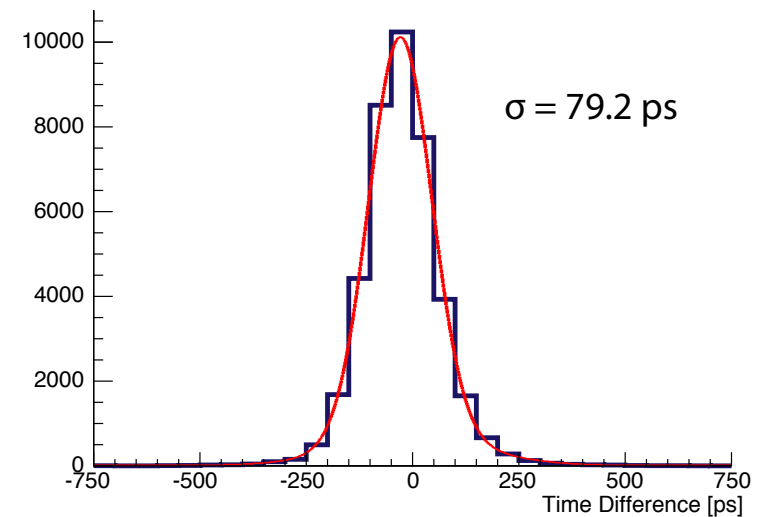
- 3 layers of 250  $\mu\text{m}$  scintillating fibres
- Read-out by silicon photomultipliers (SiPMs) and custom ASIC (MuTRiG)
- Timing resolution < 0.5 ns



# Scintillating tiles



- $\sim 0.5 \text{ cm}^3$  scintillating tiles
- Read-out by silicon photomultipliers (SiPMs) and custom ASIC (STiC)
- Timing resolution  $\sim 80 \text{ ps}$





# Very thin and fast silicon pixel sensors: HV-MAPS

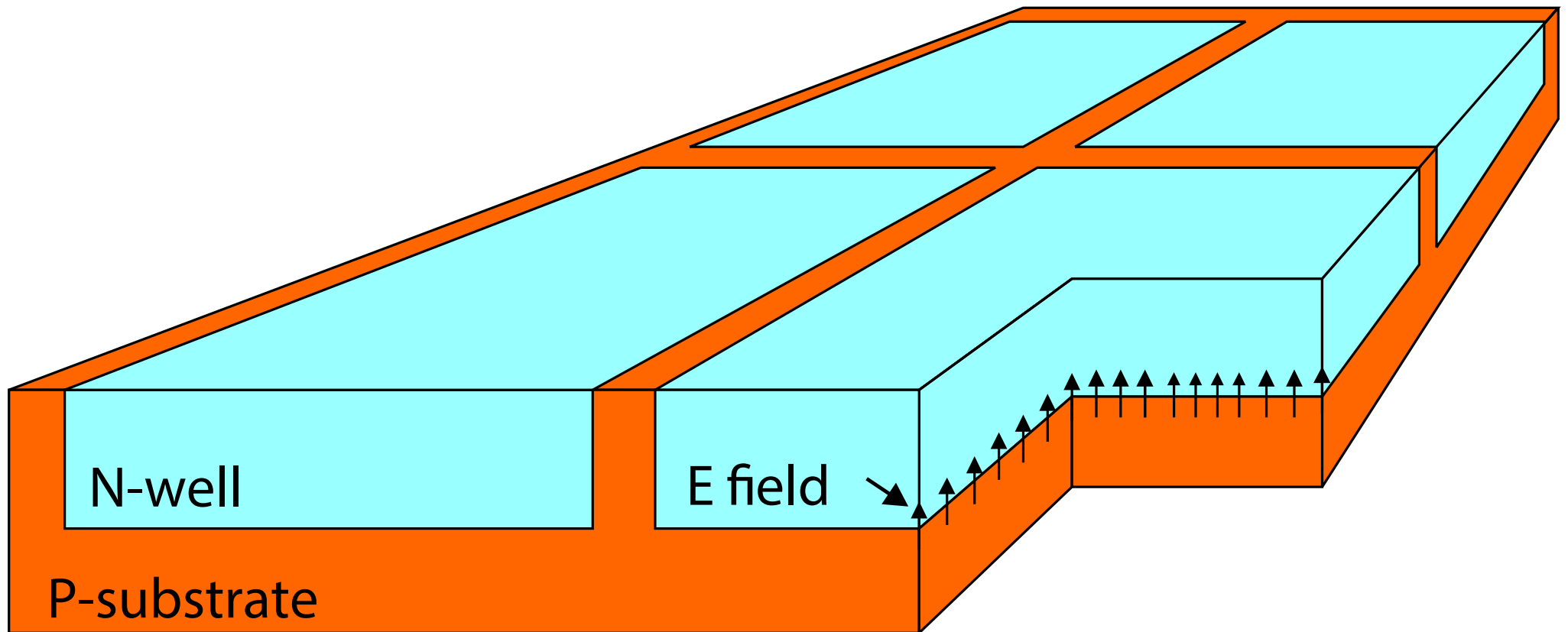




# Fast and thin sensors: HV-MAPS

High voltage monolithic active pixel sensors - Ivan Perić

- Use a high voltage commercial process (automotive industry)

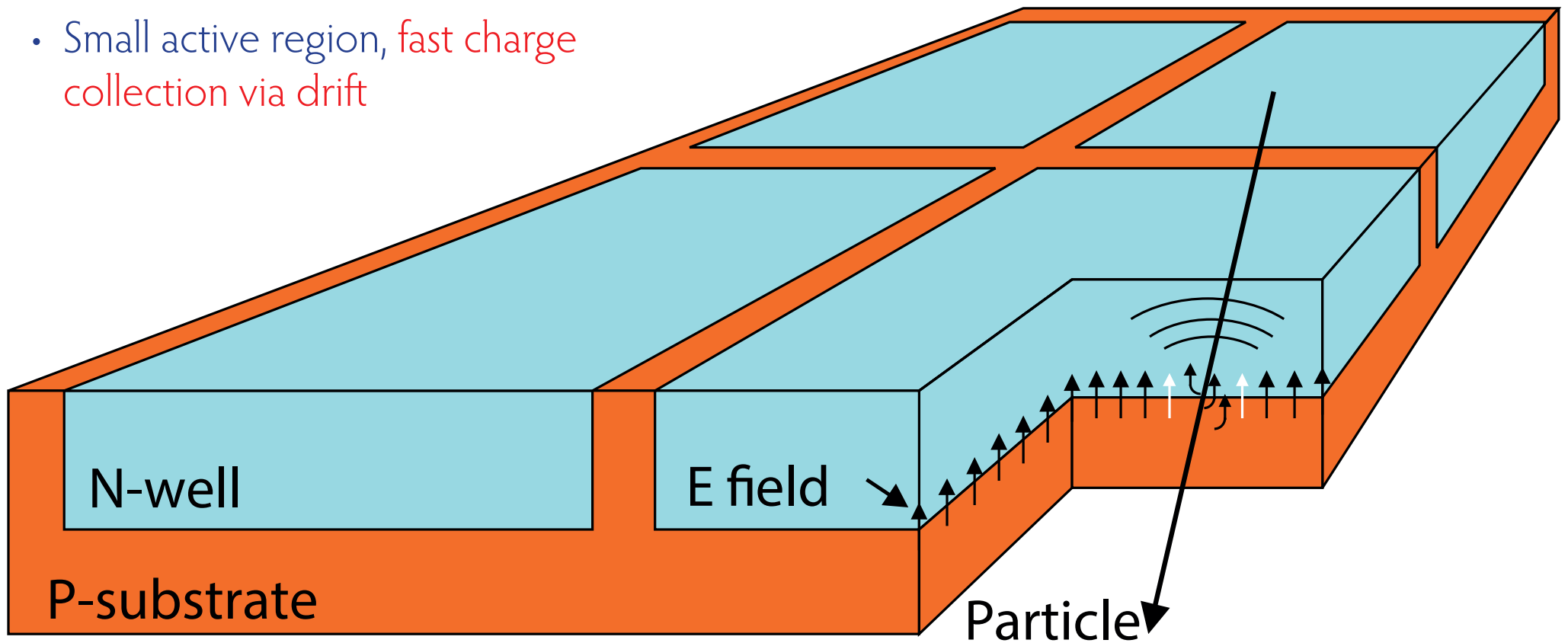




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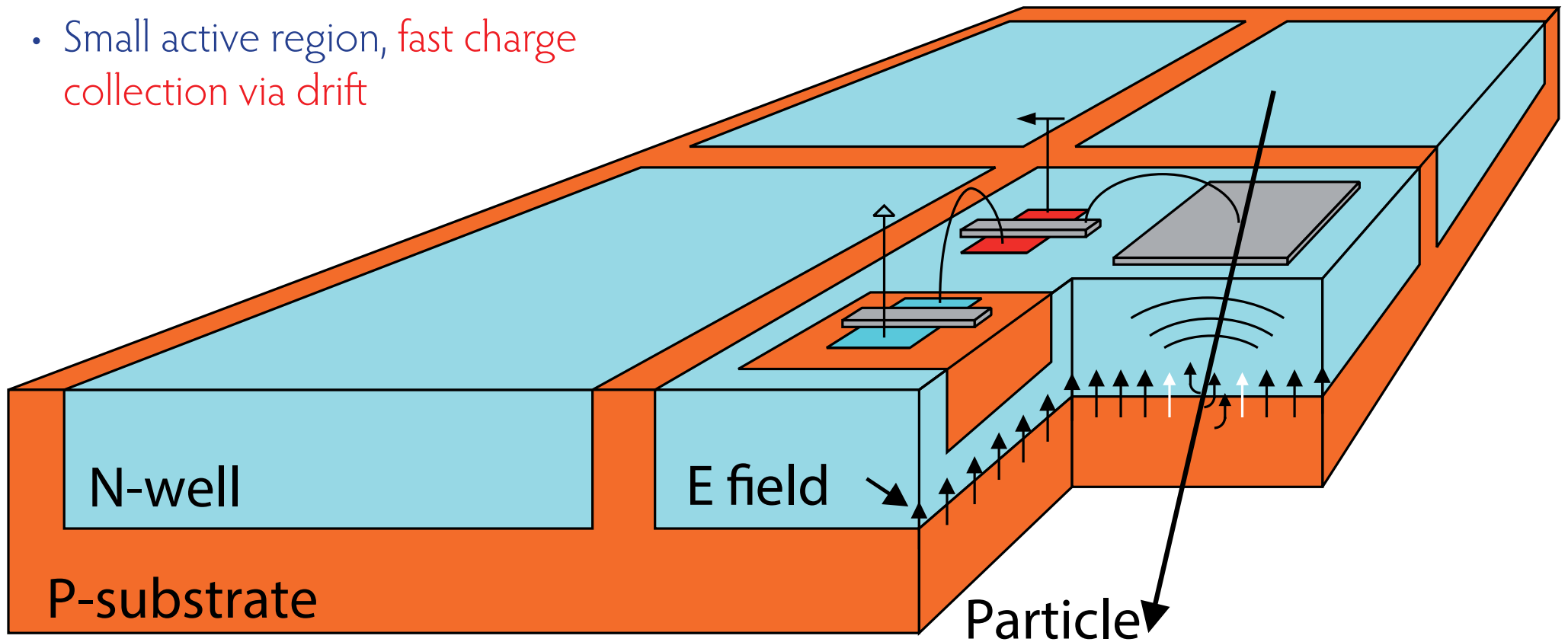
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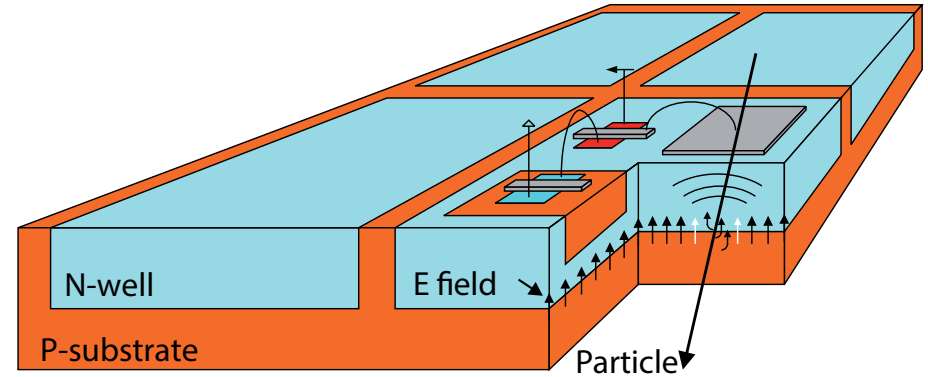
- Implement logic directly in N-well in the pixel - smart diode array
- Can be thinned down to  $\sim 50 \mu\text{m}$

(I.Perić, NIM A 582 (2007) 876)

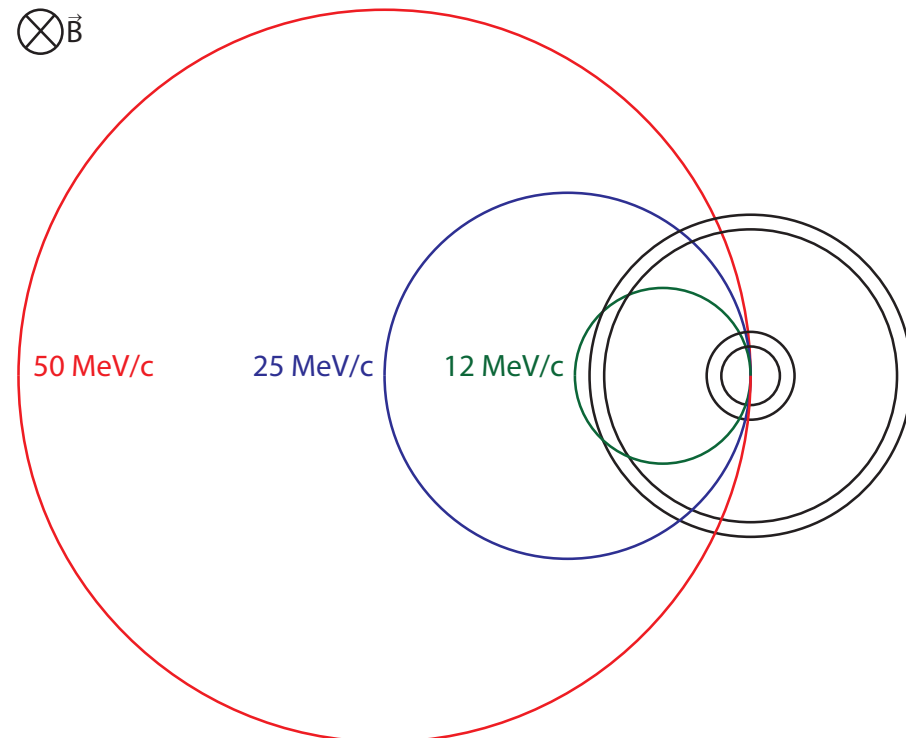


# Mu3e concept

- HV-MAPS: Thin, fast pixel sensors



- Recurler tracking: Bending in field happens mainly outside of the tracker





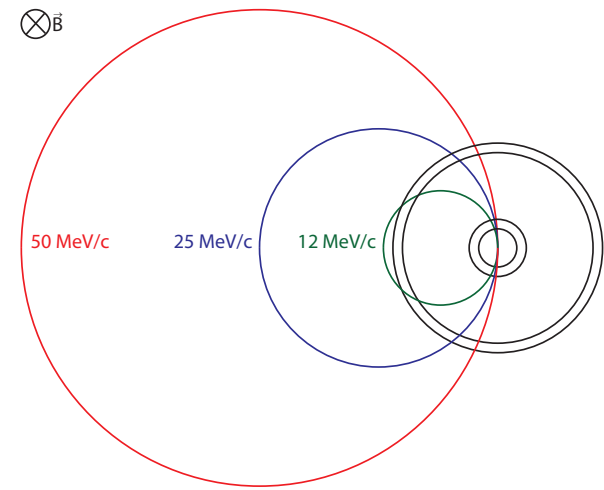
# Performance simulation



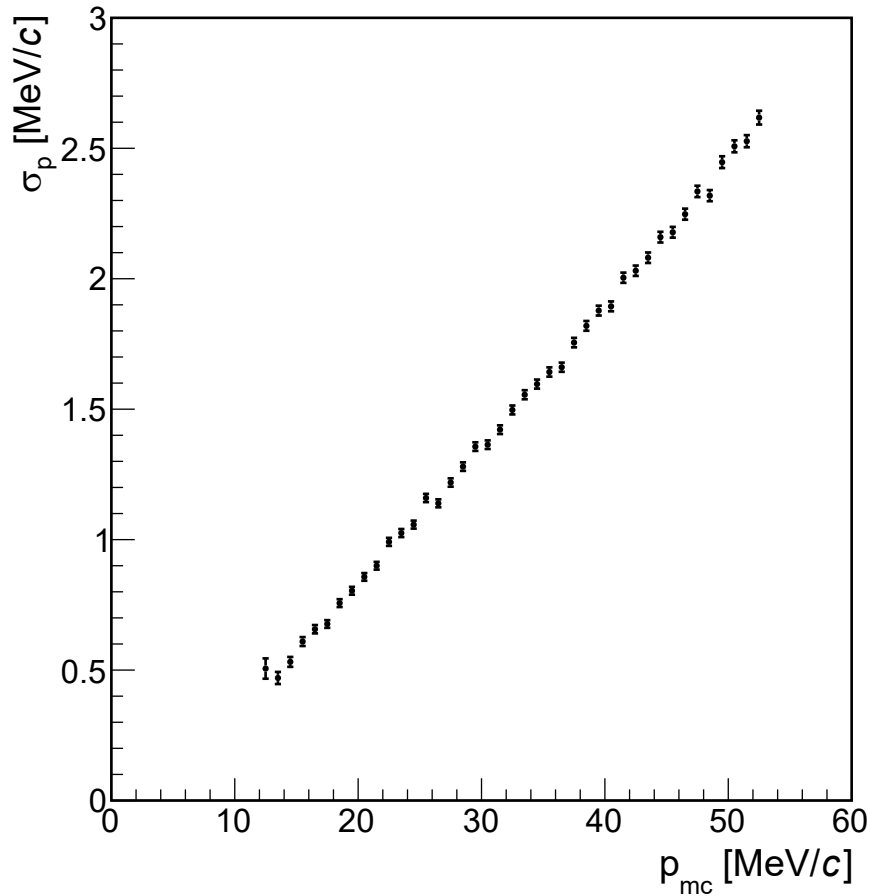


# Momentum resolution

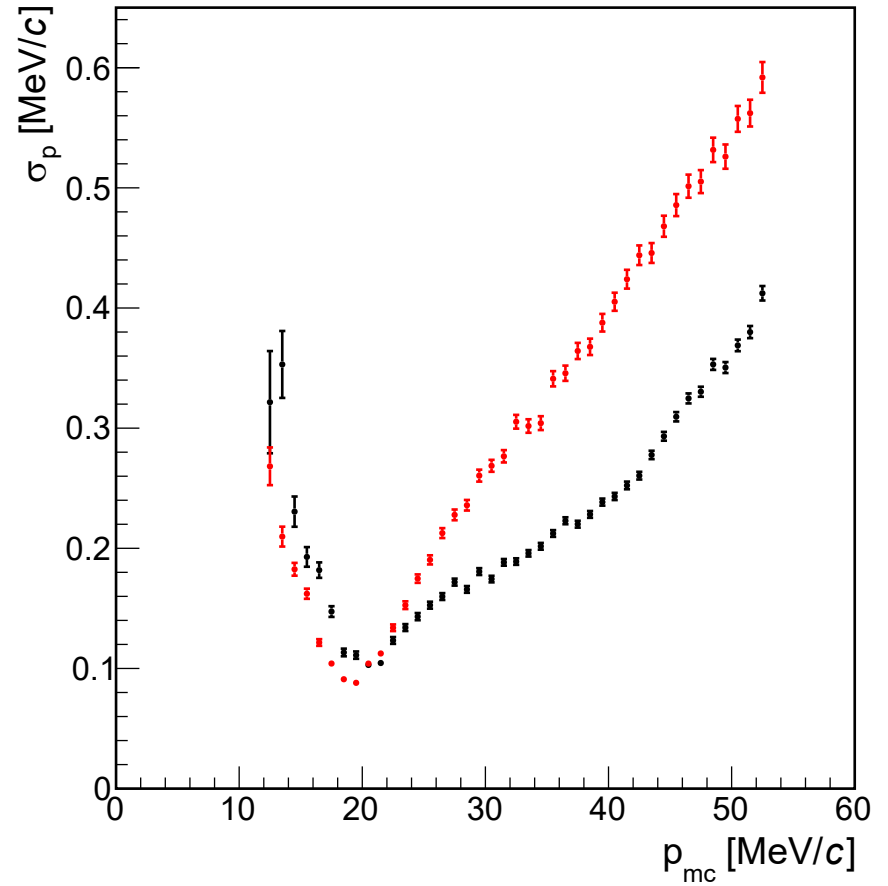
⊗ B



### Outgoing part of tracks only

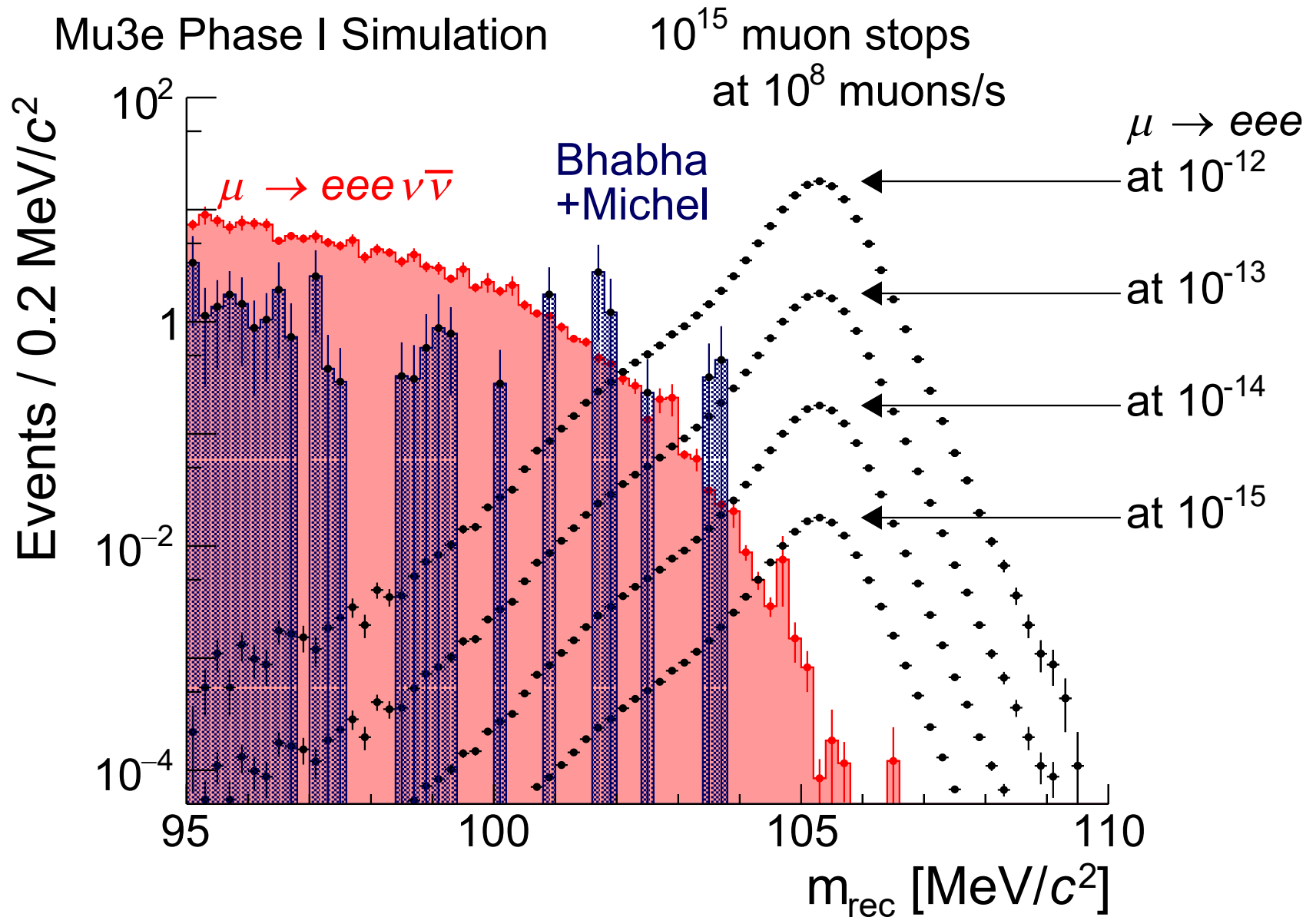


### Recurling tracks





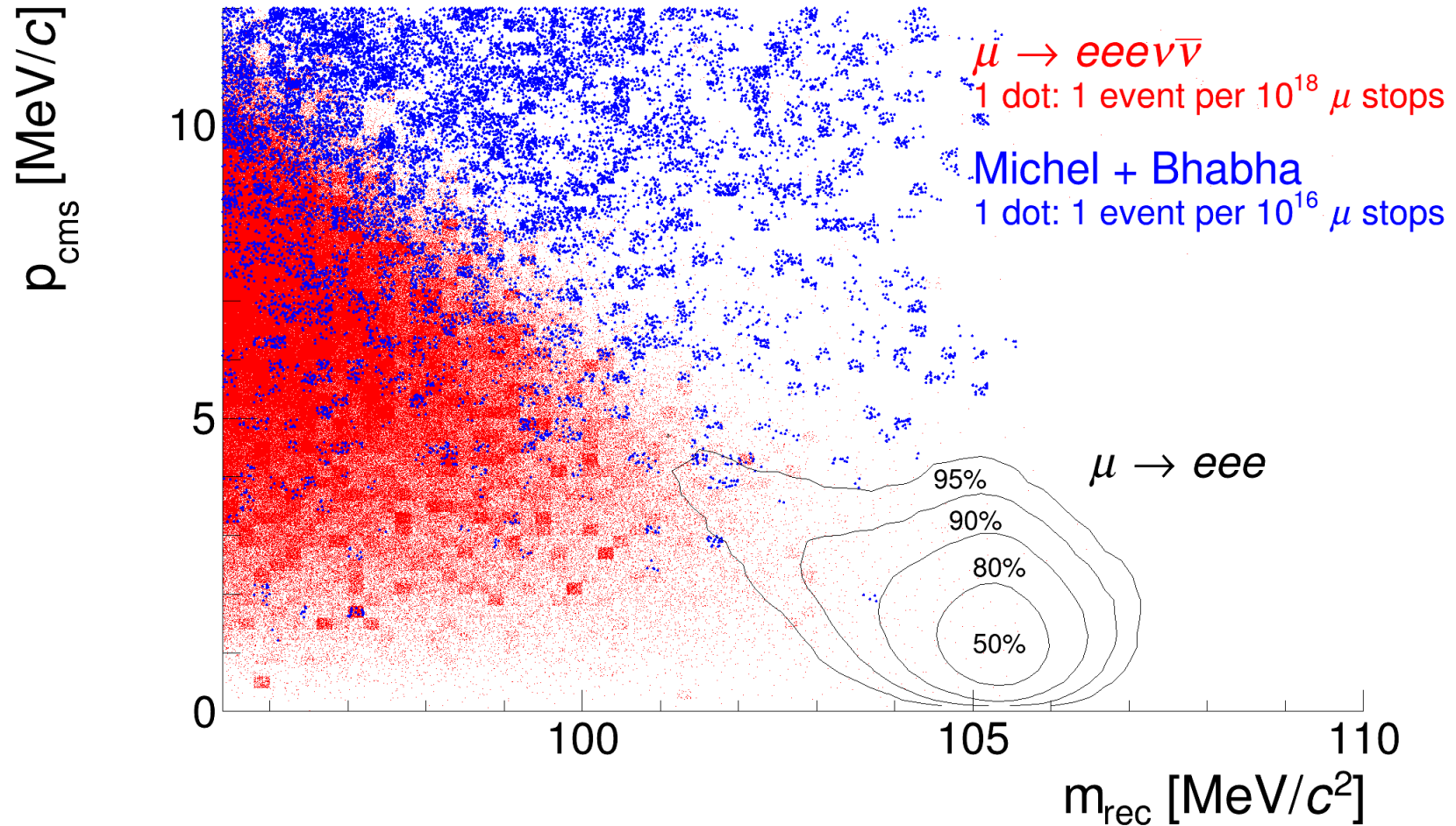
# Mass distribution





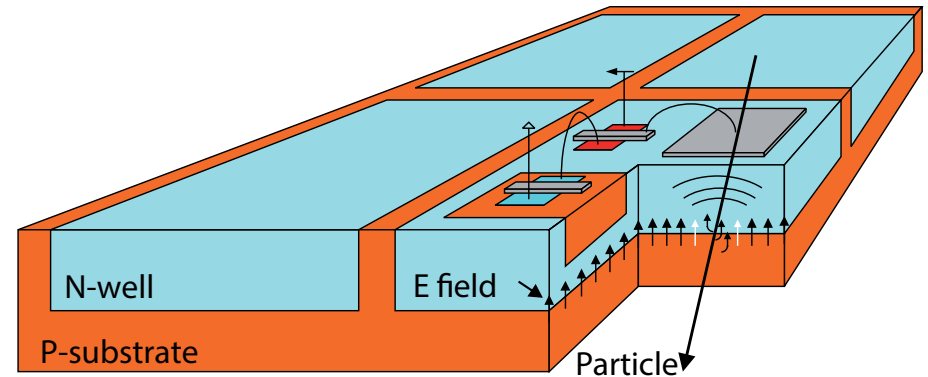
# Mass/Momentum distribution

Mu3e Phase I Simulation



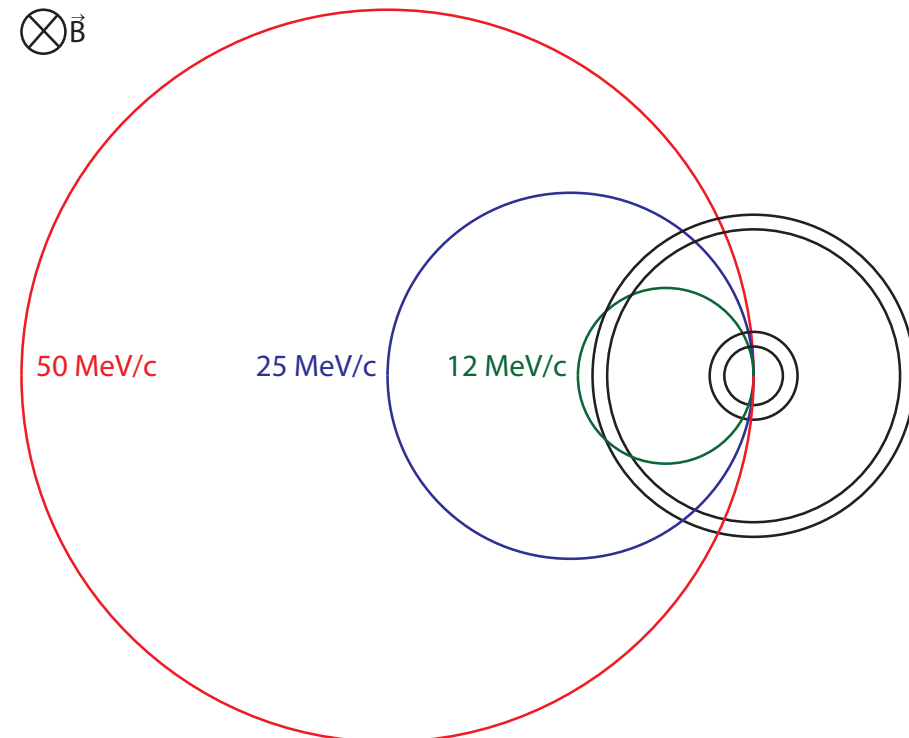
# Mu3e concept

- HV-MAPS: Thin, fast pixel sensors



- Recurler tracking: Bending in field happens mainly outside of the tracker

- Concept is 10 years old, experiment is being assembled now - what happened in the meantime?



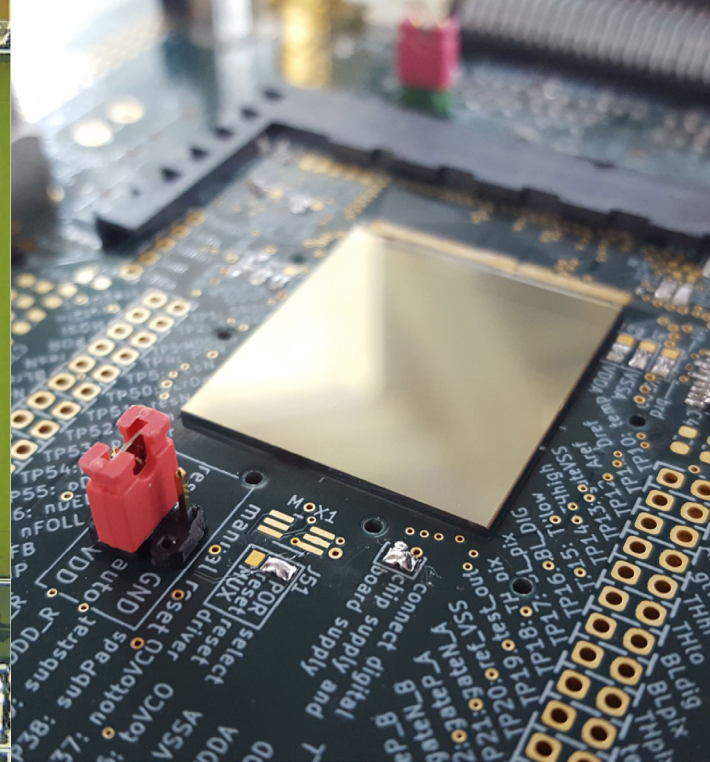
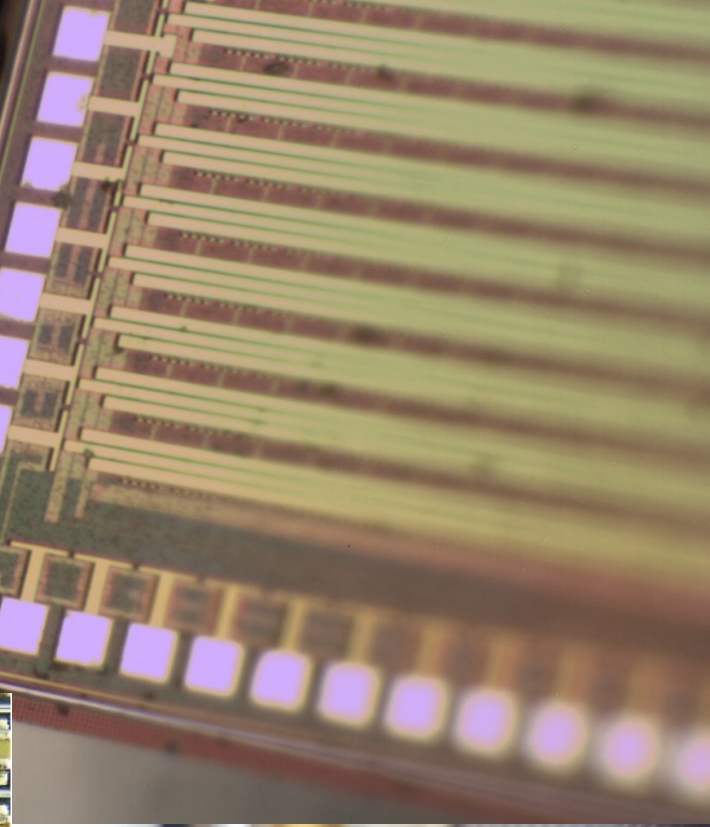




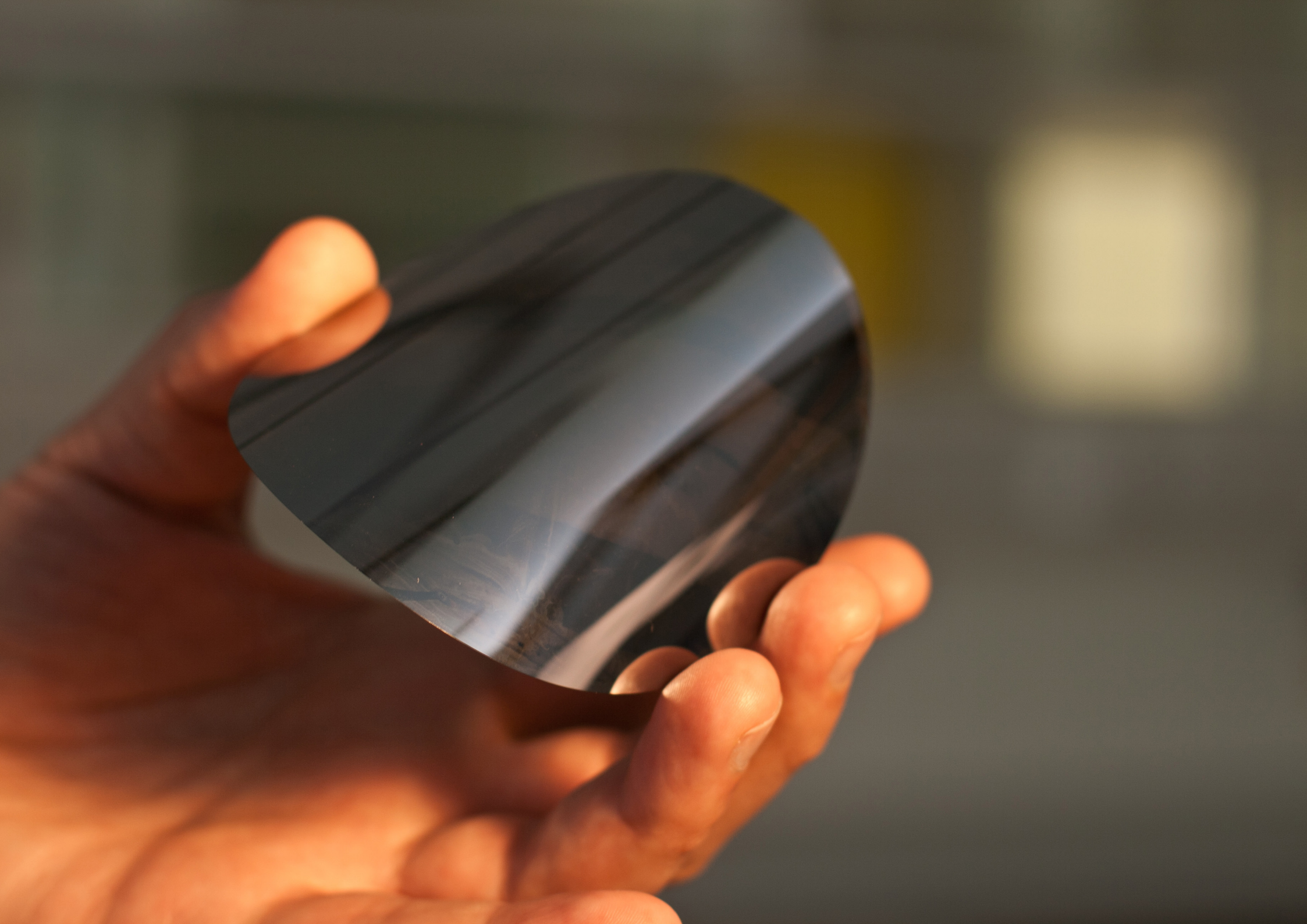
# The MuPix Prototypes

Series of HV-MAPS prototypes

- Goal: Detection and signal processing with just 50  $\mu\text{m}$  silicon
- 10 prototypes over a decade, adding features, fixing bugs
- **MuPix11**, 2 x 2  $\text{cm}^2$ , production chip, now available
- Efficiency > 99.9%
- Less than 1 Hz noise per pixel
- < 20 ns time resolution
- 200  $\text{mW}/\text{cm}^2$  power consumption



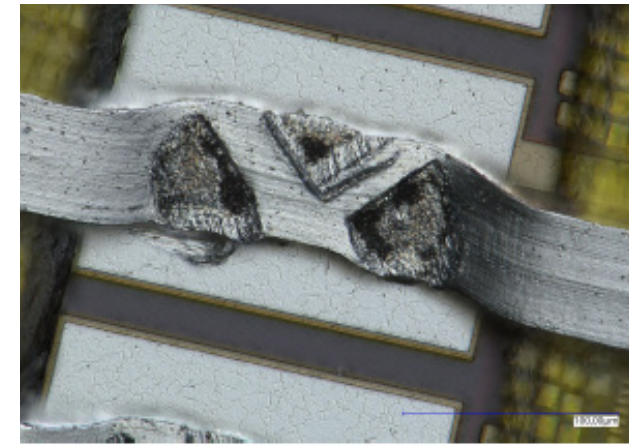
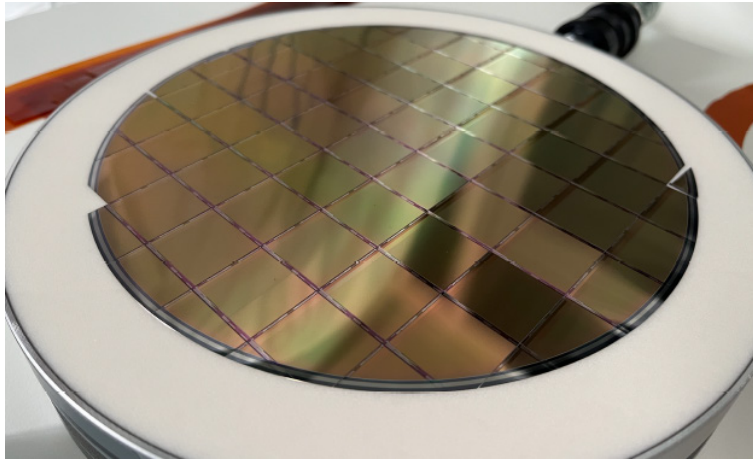






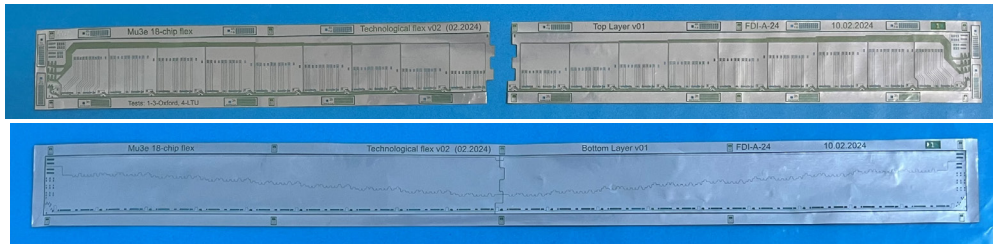


# Mechanics and Connections

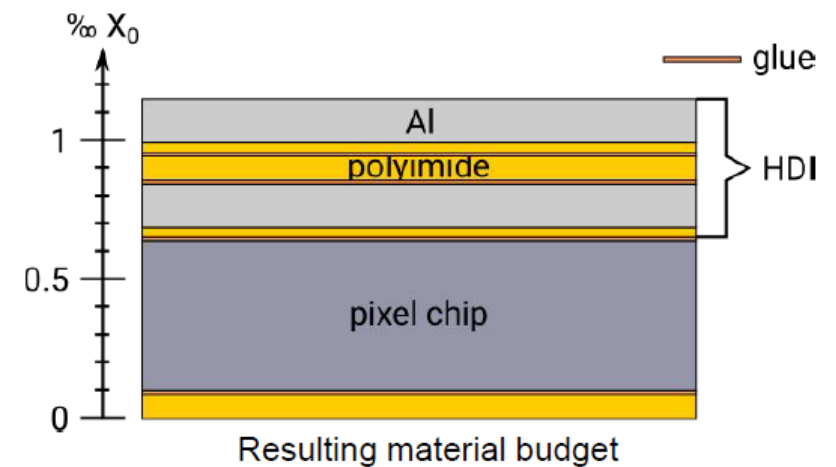
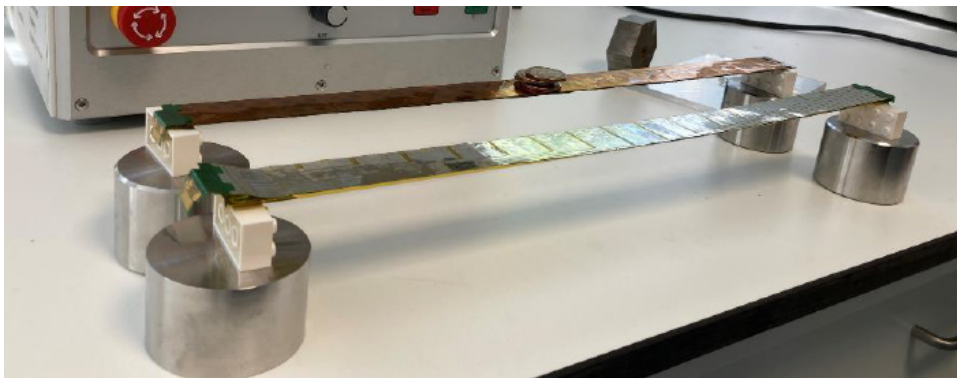


- 50  $\mu\text{m}$  silicon

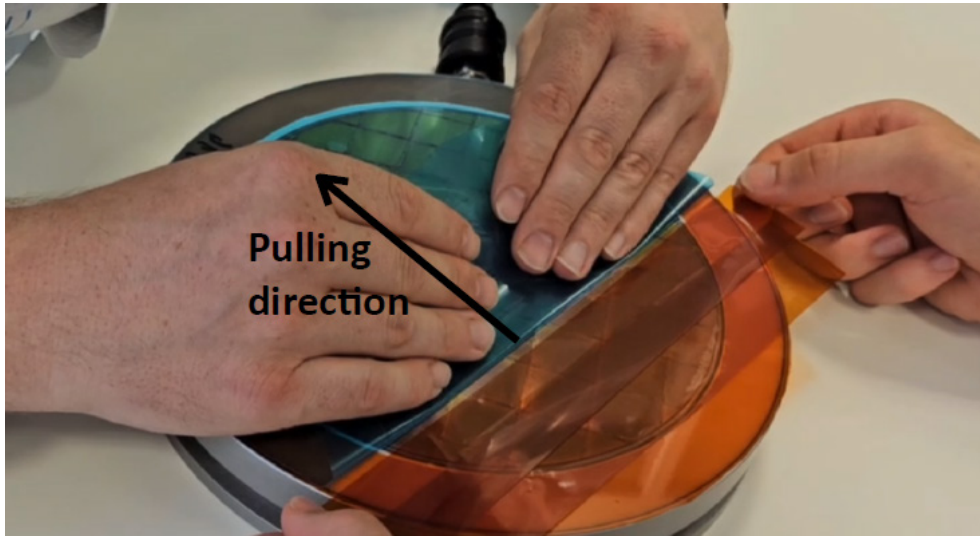
- 25  $\mu\text{m}$  Kapton™ flexprint with aluminium traces (manufactured by LTU, Kharkiv, Ukraine)  
SpTAB bonds for connections



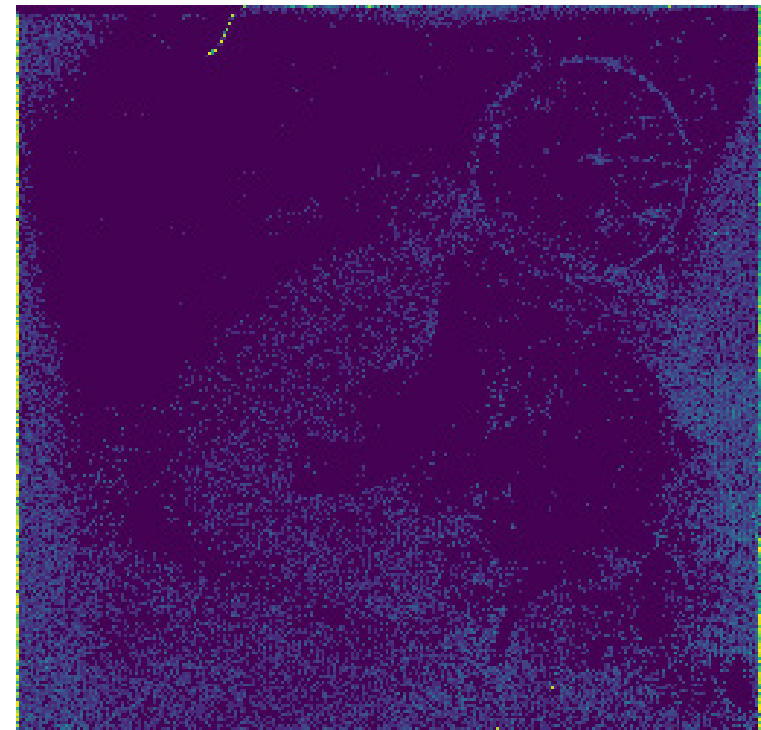
- Kapton™ or unidirectional carbon fibre supports



# Handling

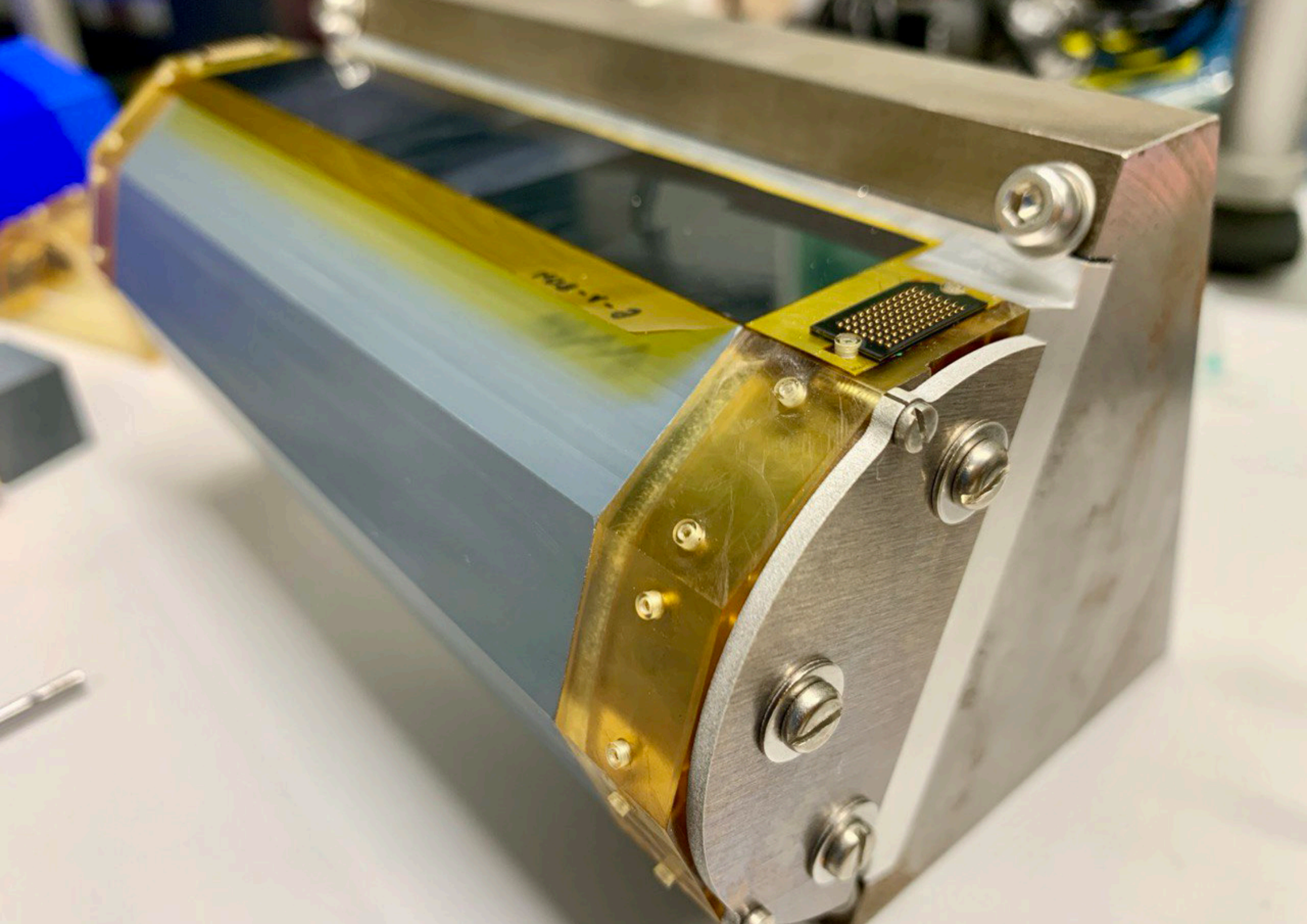


- 50  $\mu\text{m}$  chips are super fragile
- Every step needs to be qualified:  
Establish procedures and train people

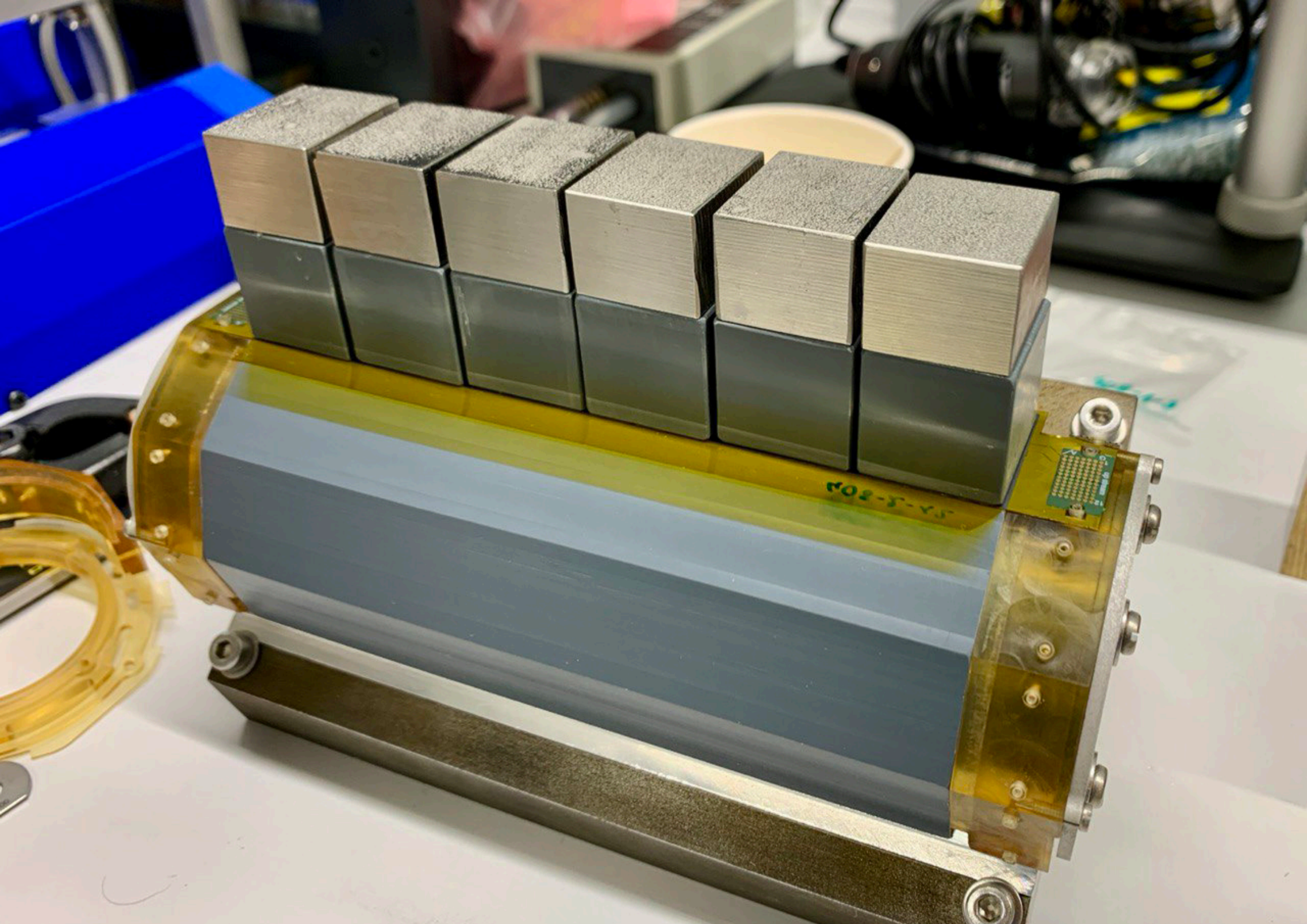


- Chips “remember” mechanical mistreatment: Here - noise map shows pick-up tool and glue







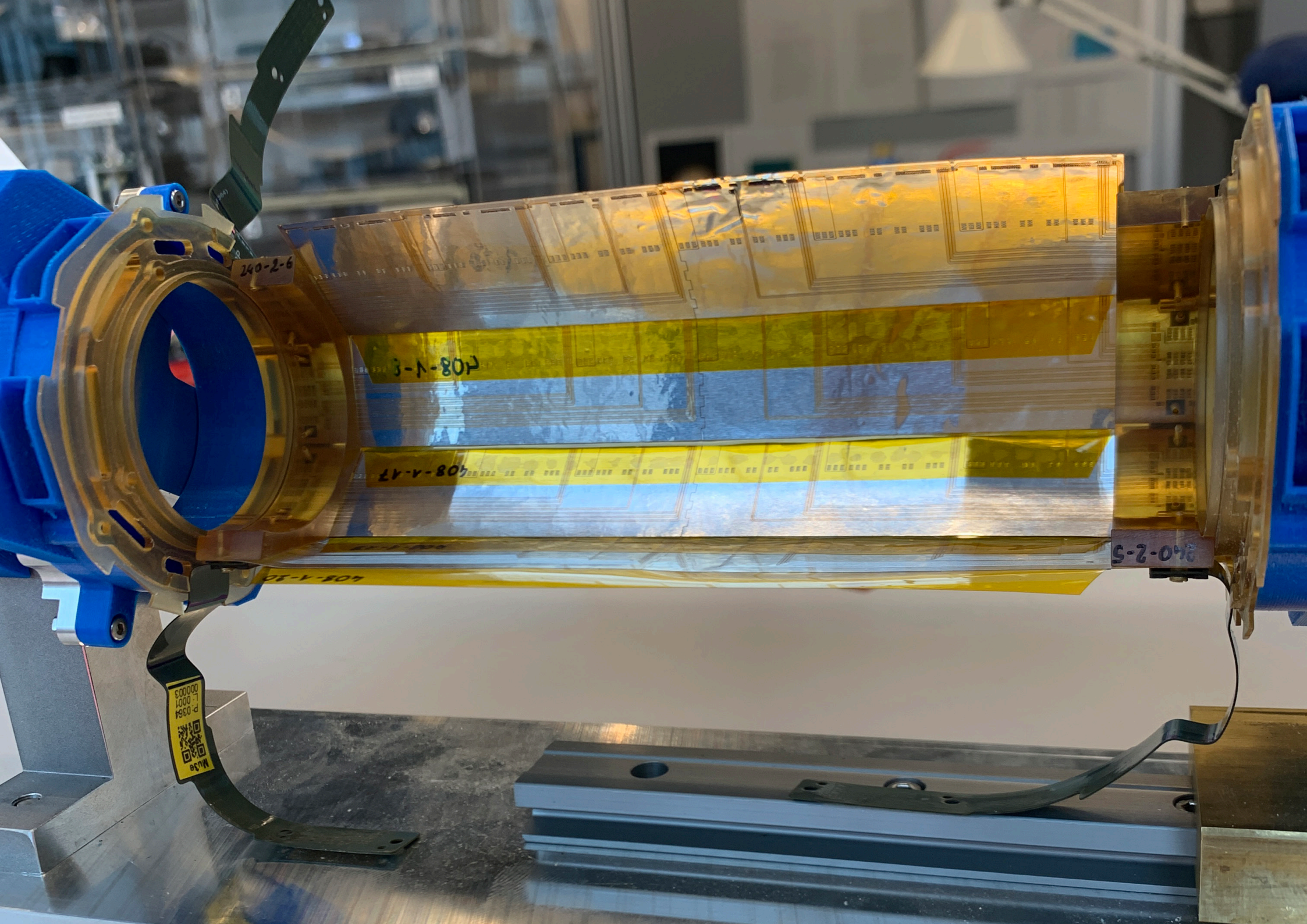


Stack of six blue piezoelectric actuators.

5A-3-202

Green PCB with a grid of components.





240-2-6

408-1-80

408-1-47

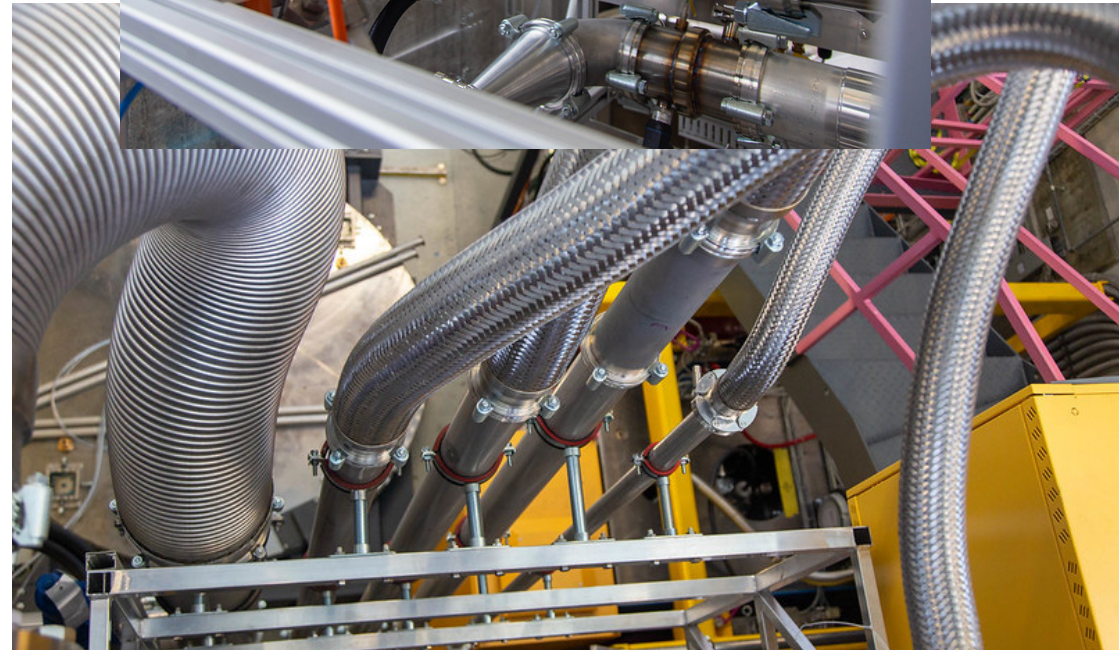
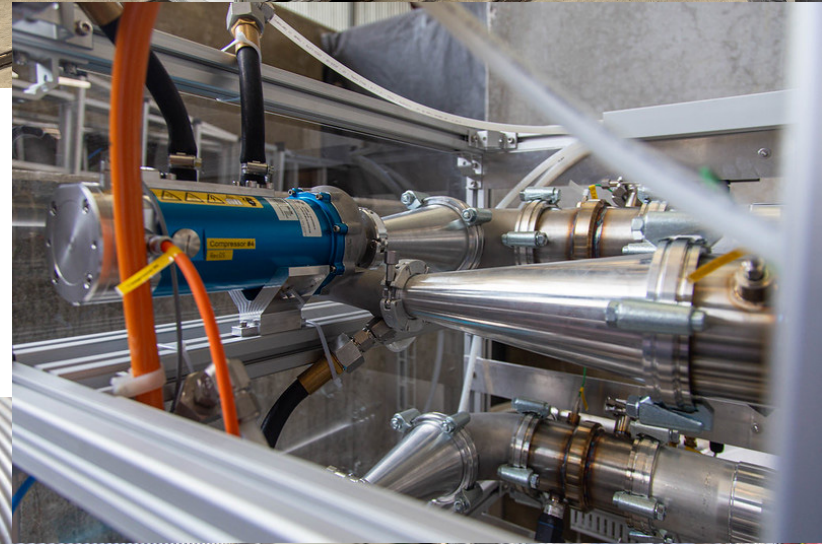
240-2-5

Made in China  
QR Code  
P-0394  
L-0001  
000003



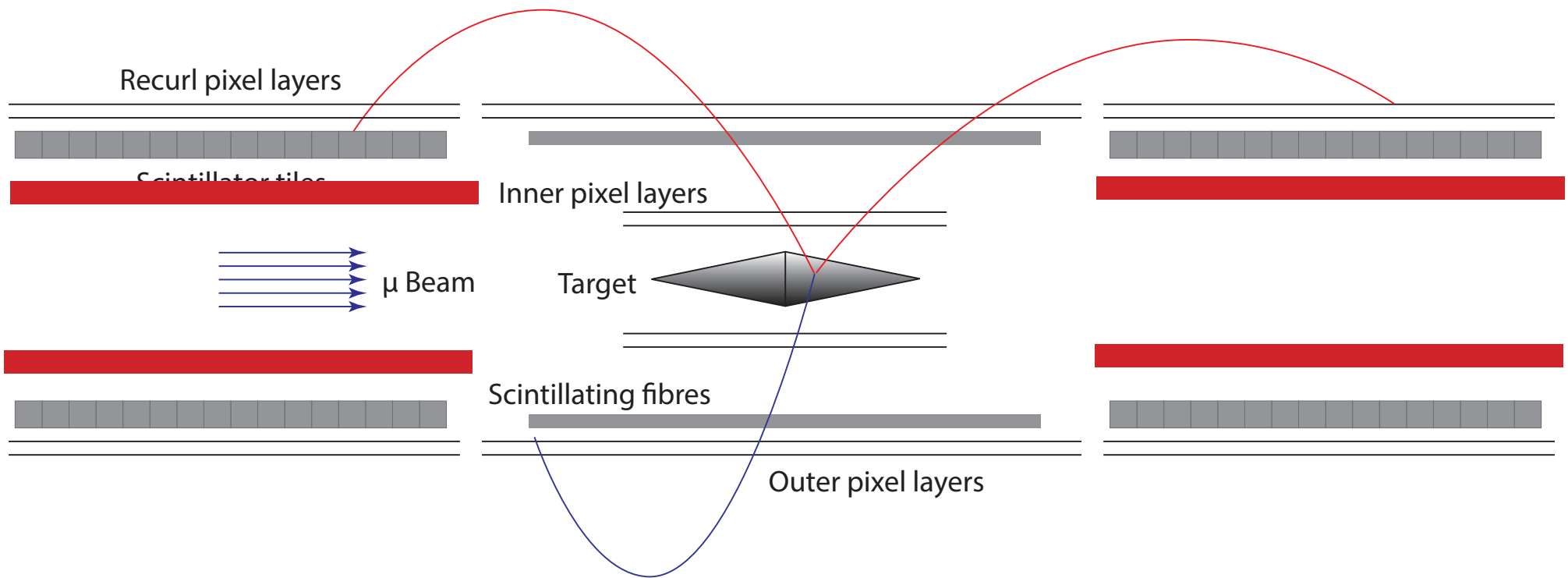
# Cooling

- $\sim 200 \text{ mW/cm}^2$  - about 2 KW for the complete pixel detector
- Add as little material as possible:  
Gaseous helium at  $\sim 0^\circ\text{C}$
- Need around 50 g/s  
( $\sim 280$  liters/s at STP...)
- Helium is difficult to pump...
- Very nice little turbocompressors available
- Cooling plant is an engineering project of its own



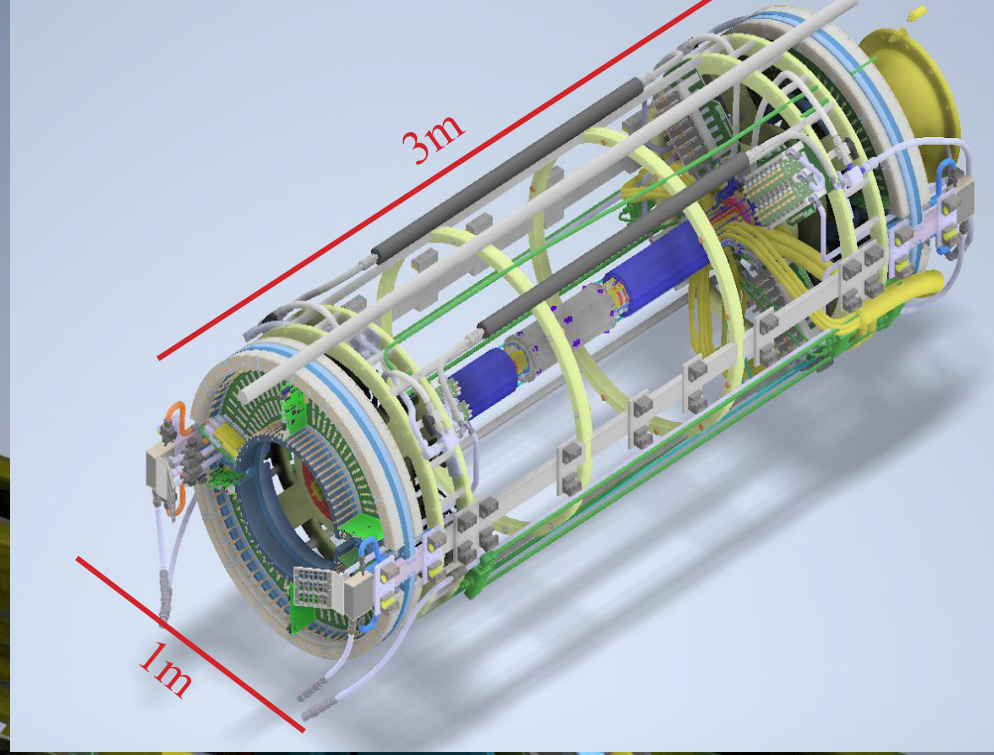
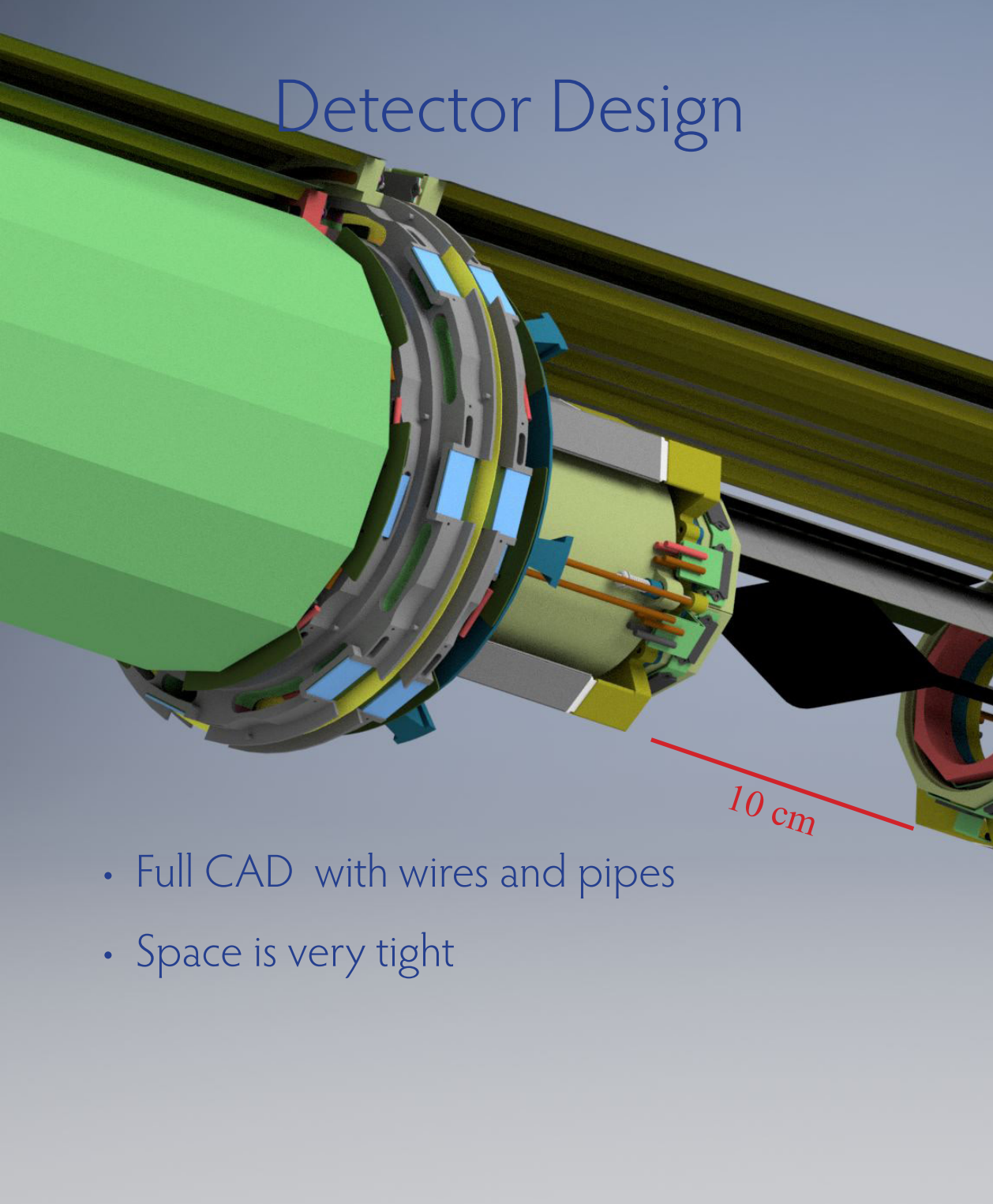


# Putting all of this together, making connections



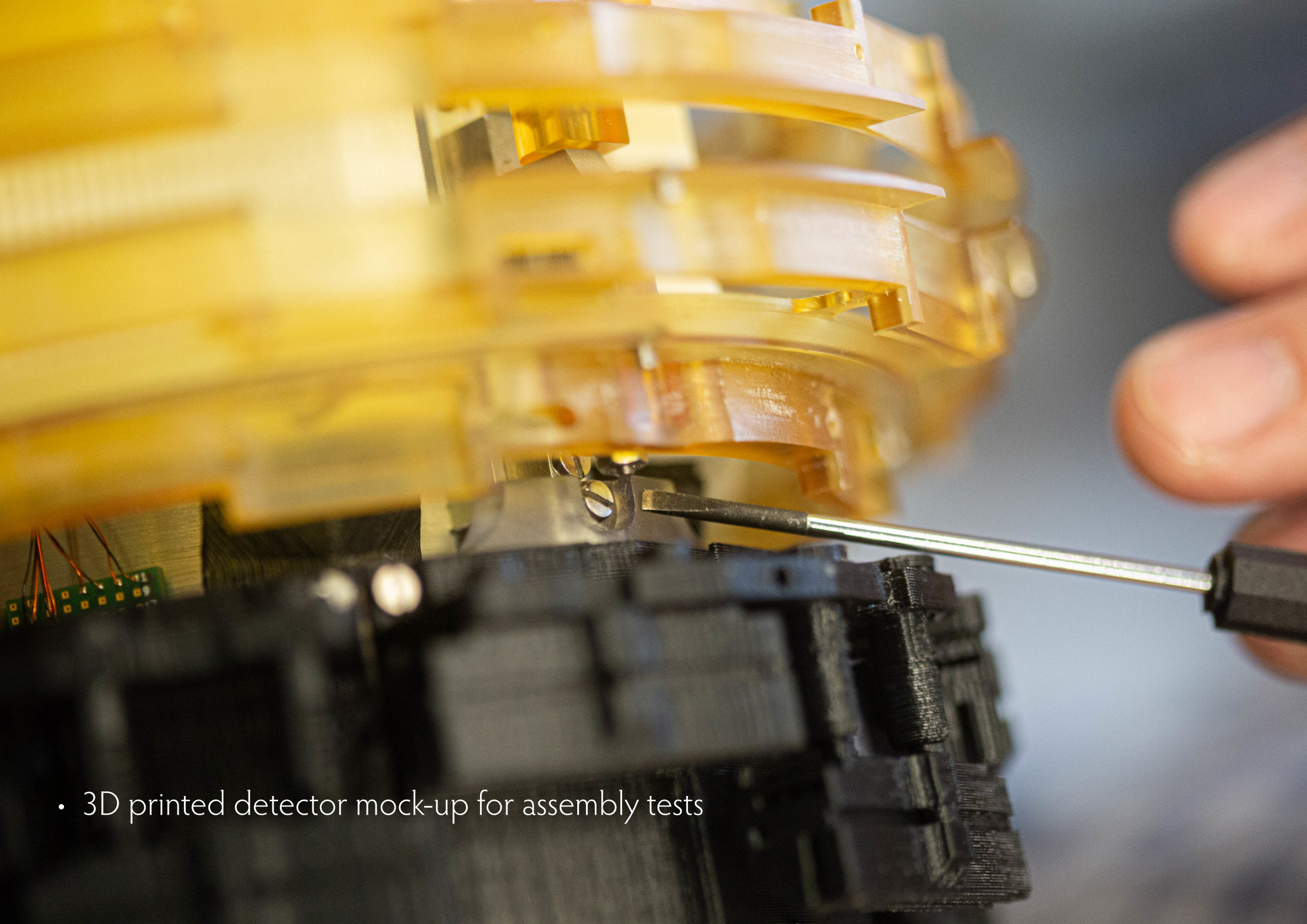


# Detector Design



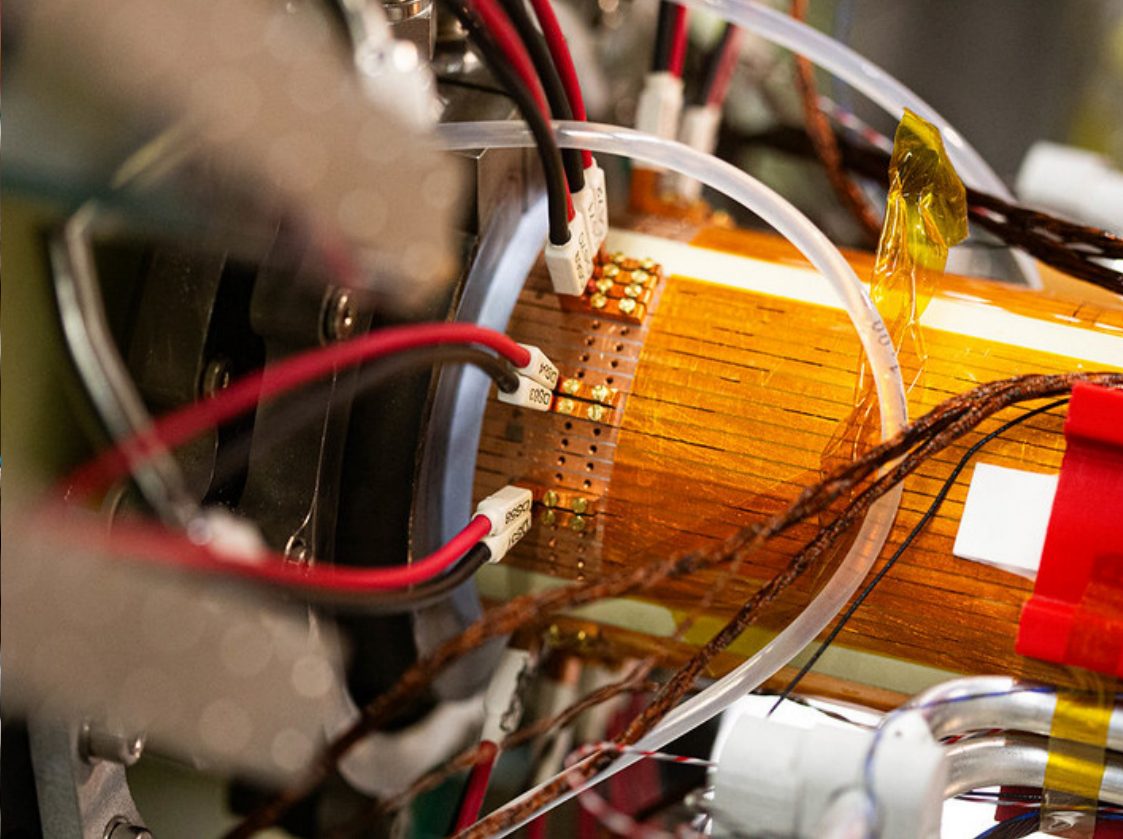
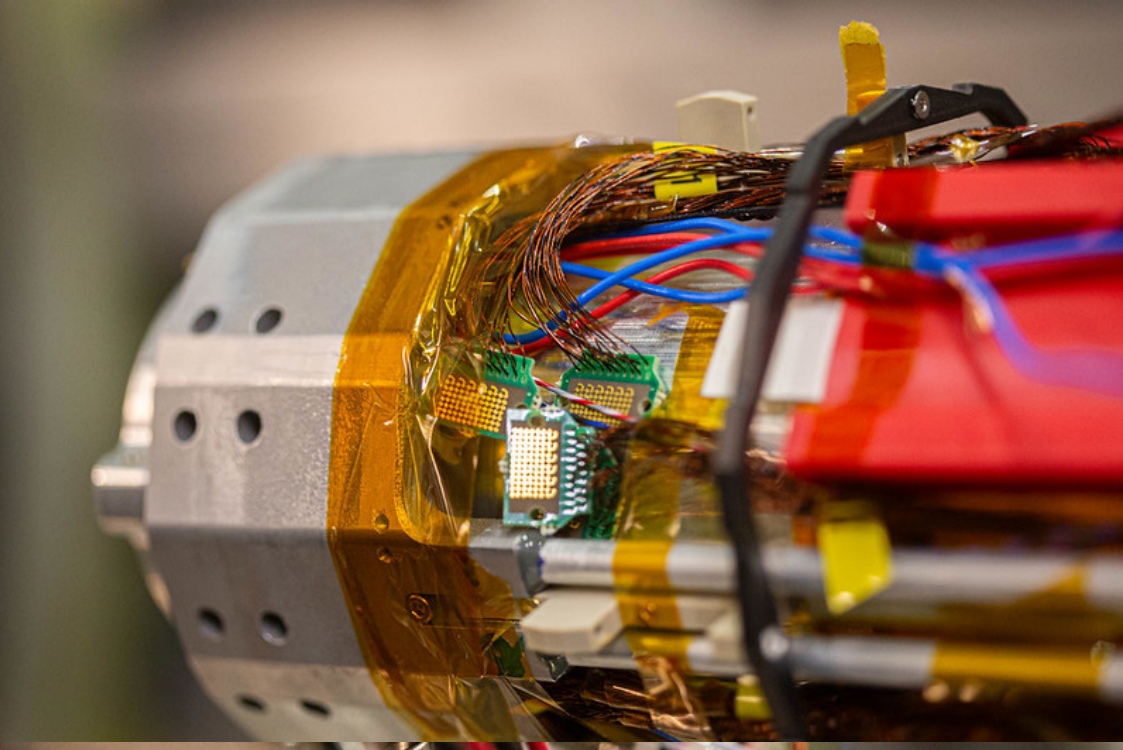
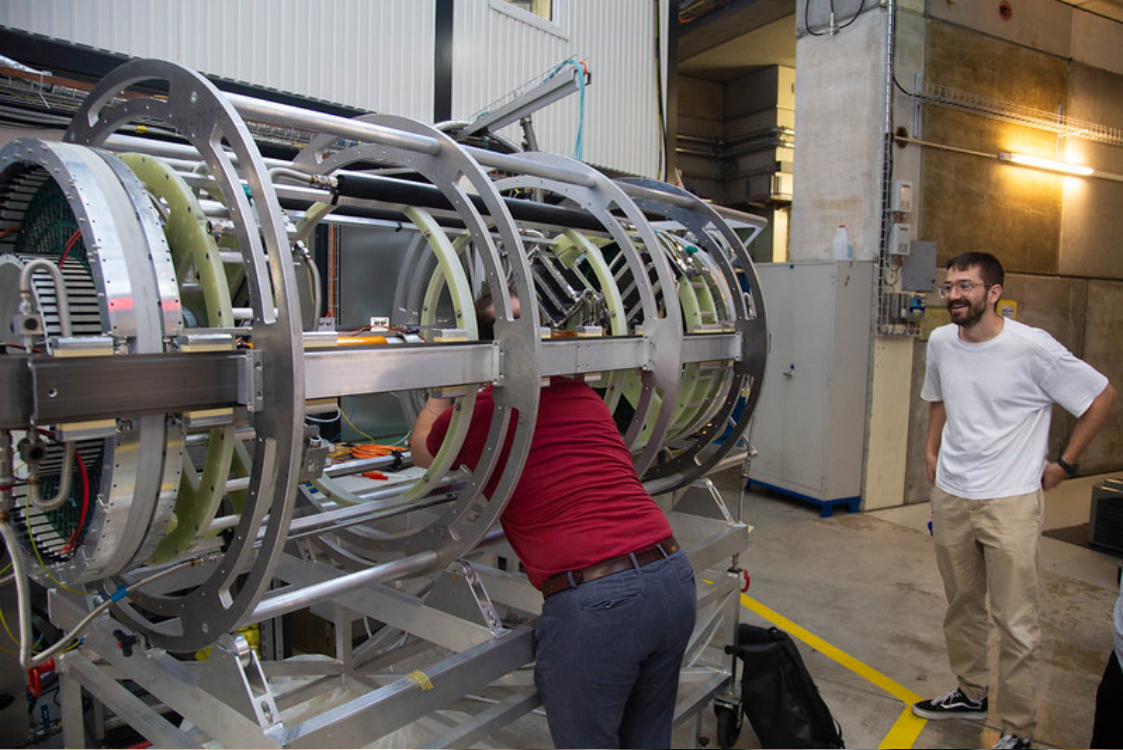
- Full CAD with wires and pipes
- Space is very tight



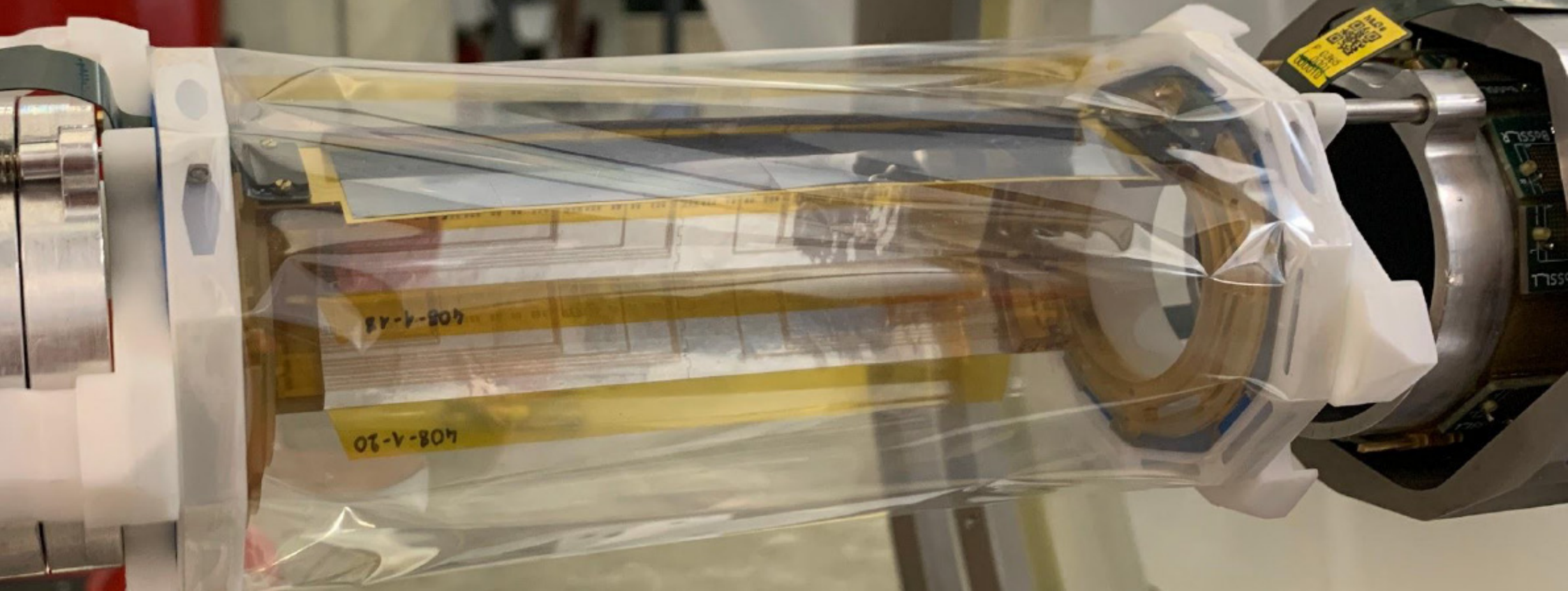


- 3D printed detector mock-up for assembly tests



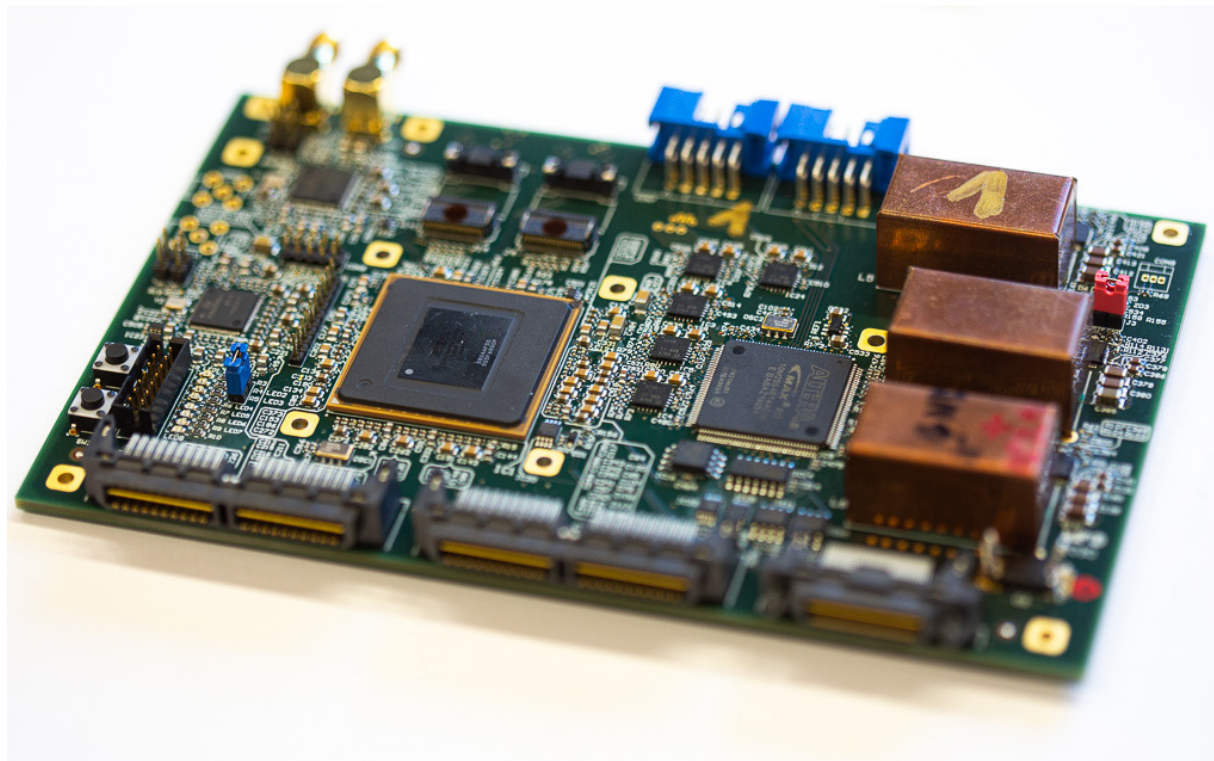






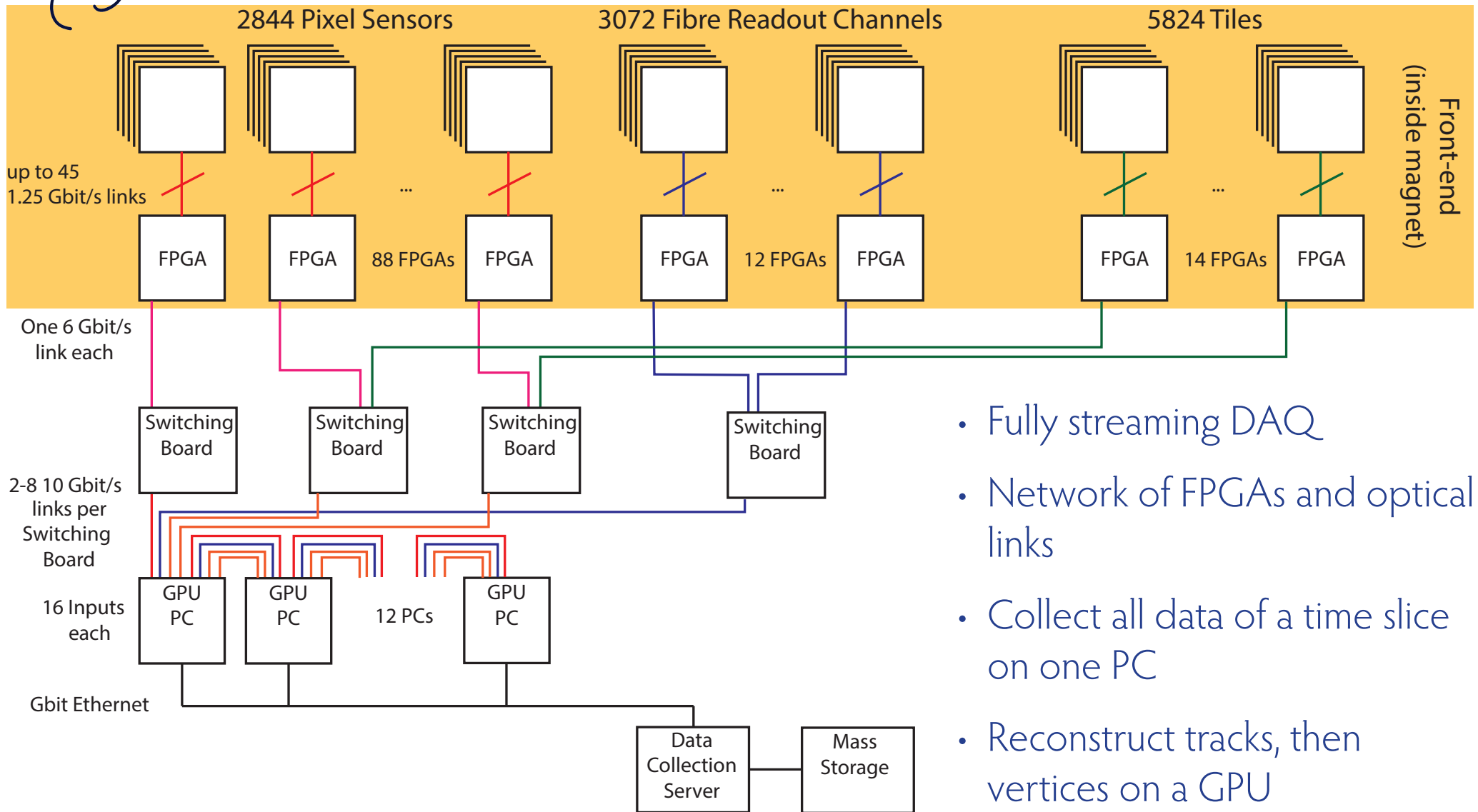


# Data Acquisition





# DAQ Design



- Fully streaming DAQ
- Network of FPGAs and optical links
- Collect all data of a time slice on one PC
- Reconstruct tracks, then vertices on a GPU
- Write interesting events to disk





# GPU reconstruction

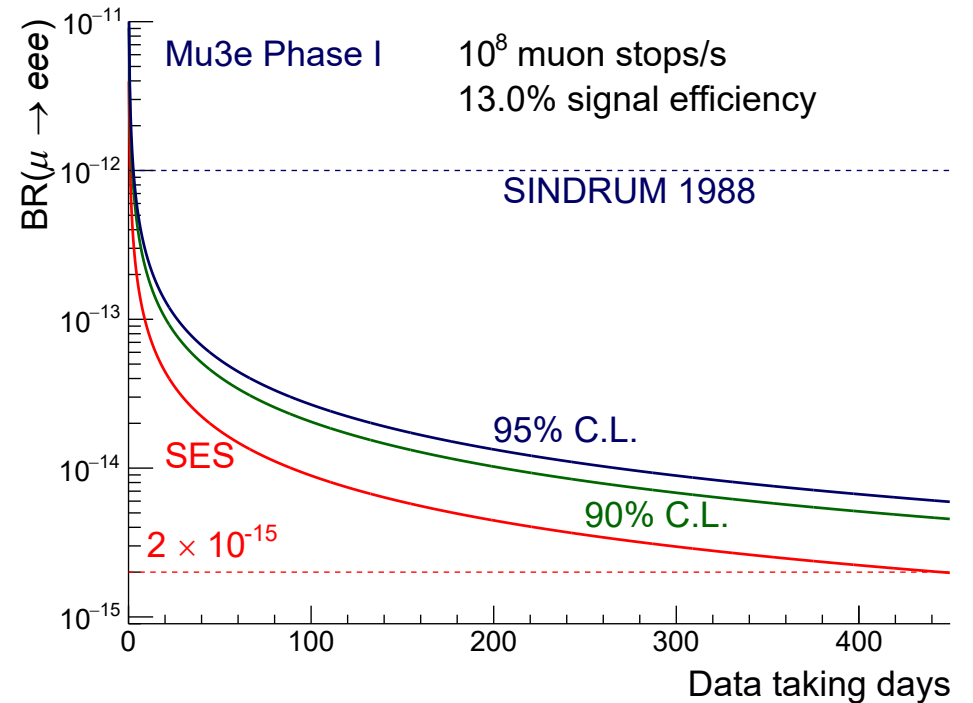


- GPU reconstruction on gaming cards
- Have achieved  $> 10^9$  track fits/s per GPUs (Nvidia GTX 980)
- Twelve GTX 1080Ti are sufficient for dealing with  $10^8$  muon decays/s
- ~ 8 years pass
- Just four RTX 4090 can handle Mu3e phase I...

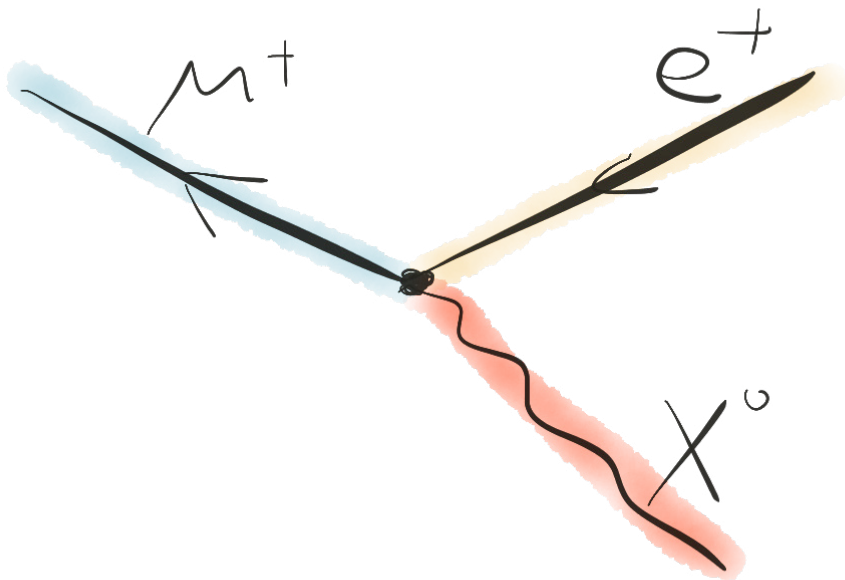


# Status and plans

- Assembly now, test run in 2025
- First physics data taking in 2026
- Phase I expected SES is a few  $10^{-15}$
- Upgrade to high-intensity muon beam line likely in 2027
- 20 times more beam:  
A lot of new challenges
- Gradual transition to Phase II



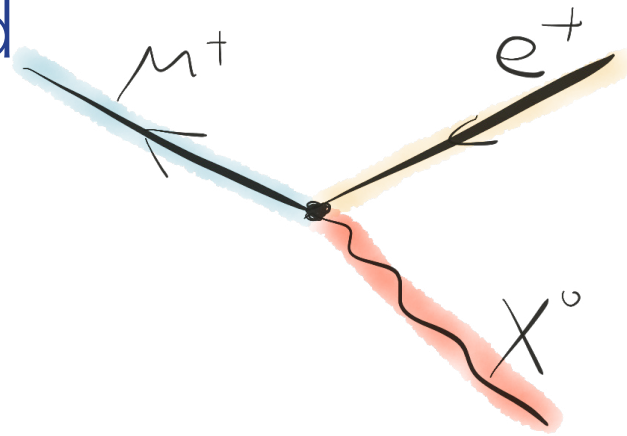
# Familons in Mu3e



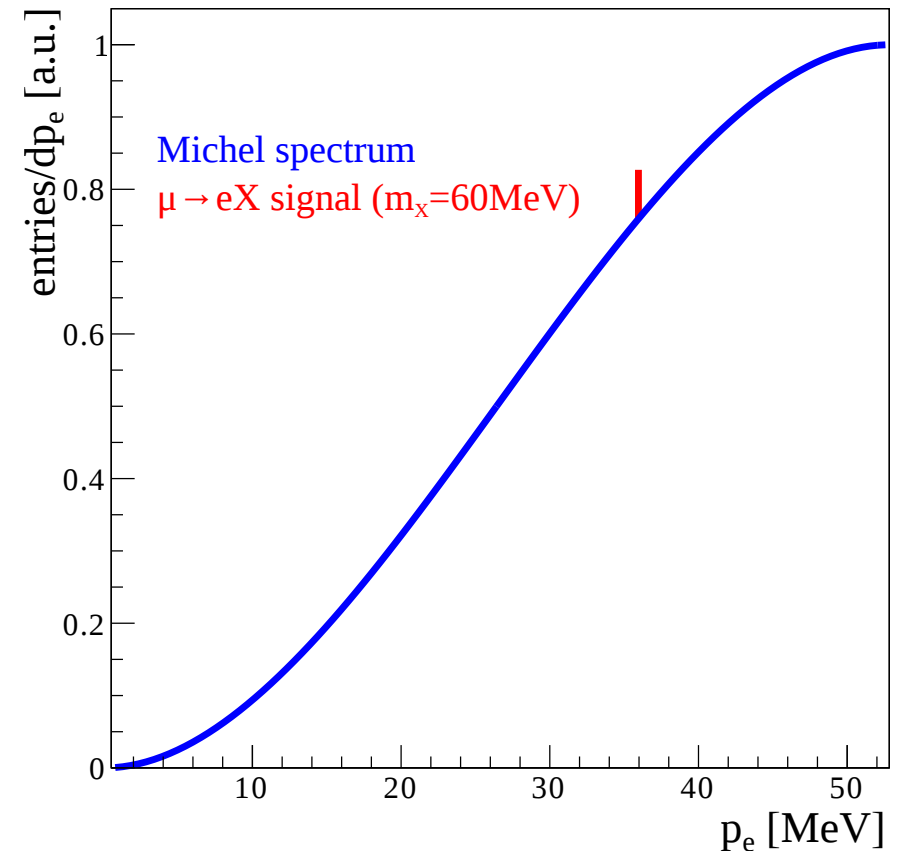
- Spontaneously broken flavour symmetry: Goldstone boson(s) called **familons**
- Can be a light dark matter candidate
- Lead to  $\mu \rightarrow eX$ , where  $X$  a familon
- $\mu \rightarrow eX$  can also show up in other models, search for it with the large muon decay data set at Mu3e



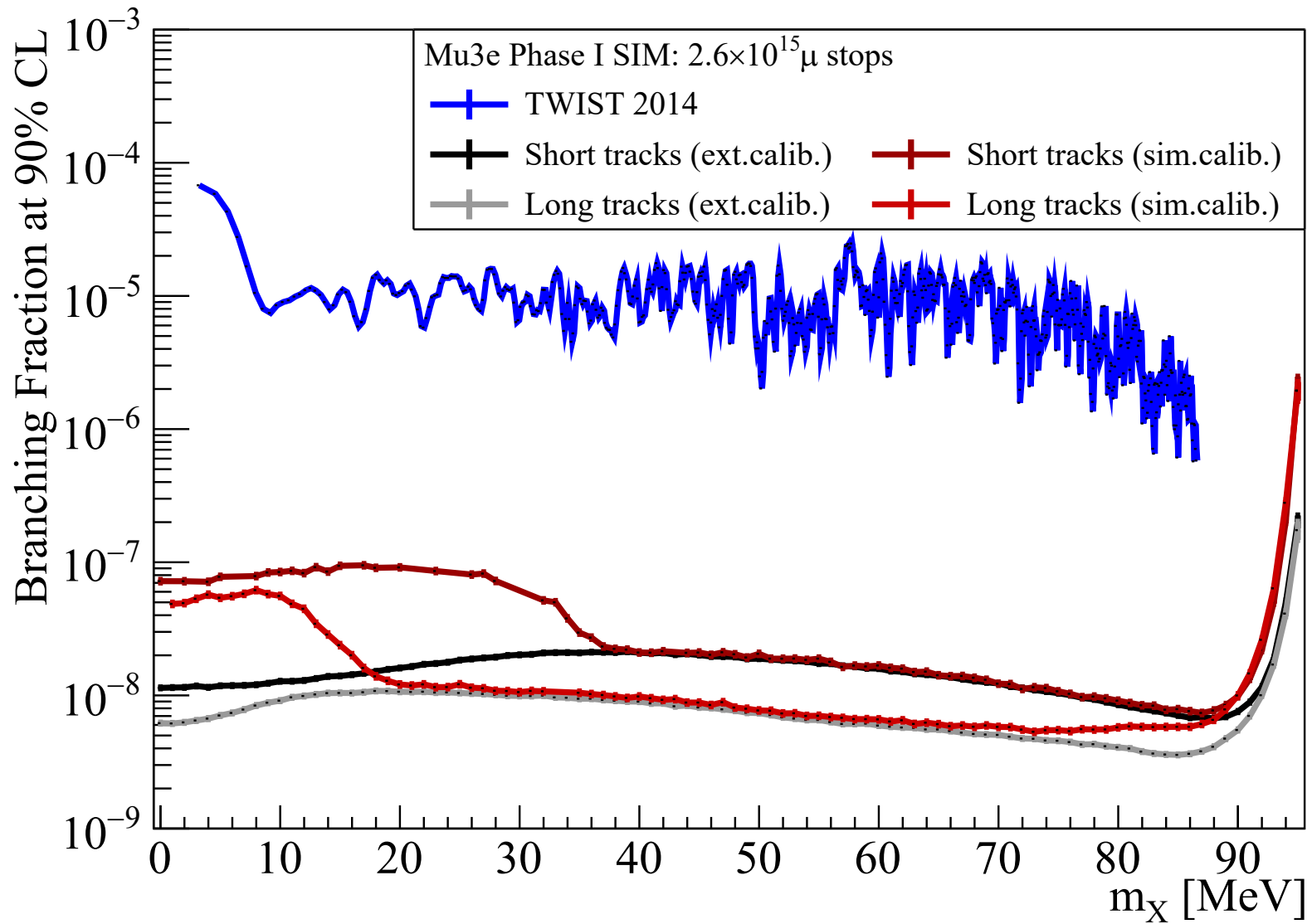
# Signature and Background



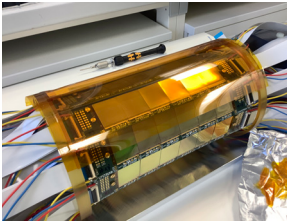
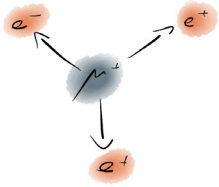
- Signal: Two-body decay:  
Monoenergetic positron
- Background: All other positrons,  
dominated by Michel decay,  
smooth momentum distribution
- Bump hunt on the positron spectrum  
(all tracks - needs to run online)



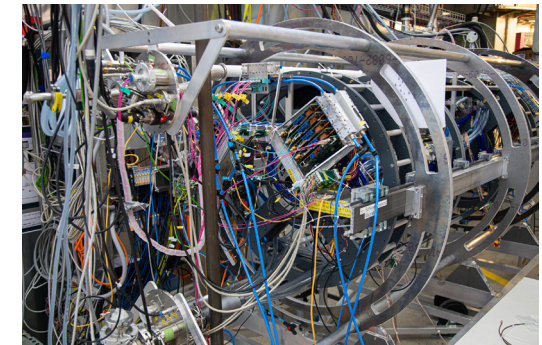
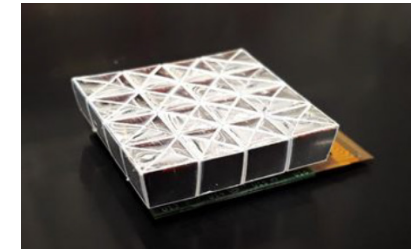
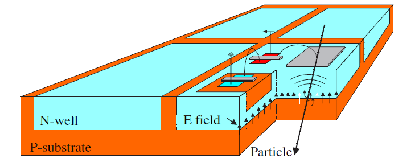
# Projections



# Conclusion



- Mu3e aims for  $\mu \rightarrow eee$  at the  $10^{-16}$  level
- First large scale use of HV-MAPS
- Build detector layers thinner than a hair
- Timing at the 100 ps level
- Reconstruct  $>10^8$  tracks/s in  $\sim 100$  Gbit/s on  $\sim 4$  GPUs
- Integration and commissioning 2024/25
- ... and then finally data!



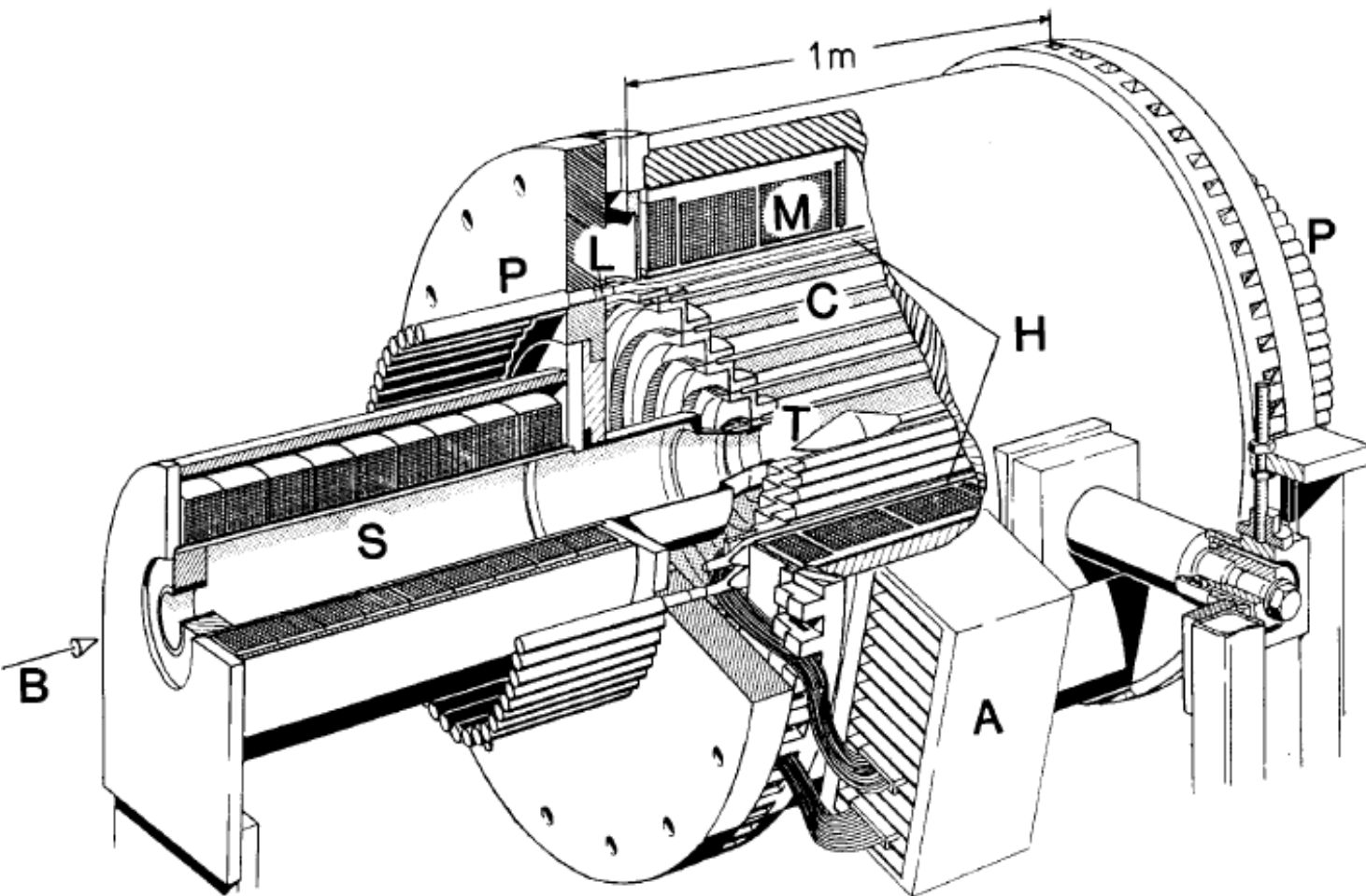


# Backup



Searching for  $\mu^+ \rightarrow e^+e^-e^+$  in the past:

SINDRUM



B: Muon Beam

S: Focusing Solenoid

T: Target

C: Five cylindrical multiwire  
proportional chambers

H: Scintillator hodoscope

L: Light-guides

P: Photomultipliers

A: Preamplifiers

M: Magnet coil  
(normal conducting,  
0.6 T)

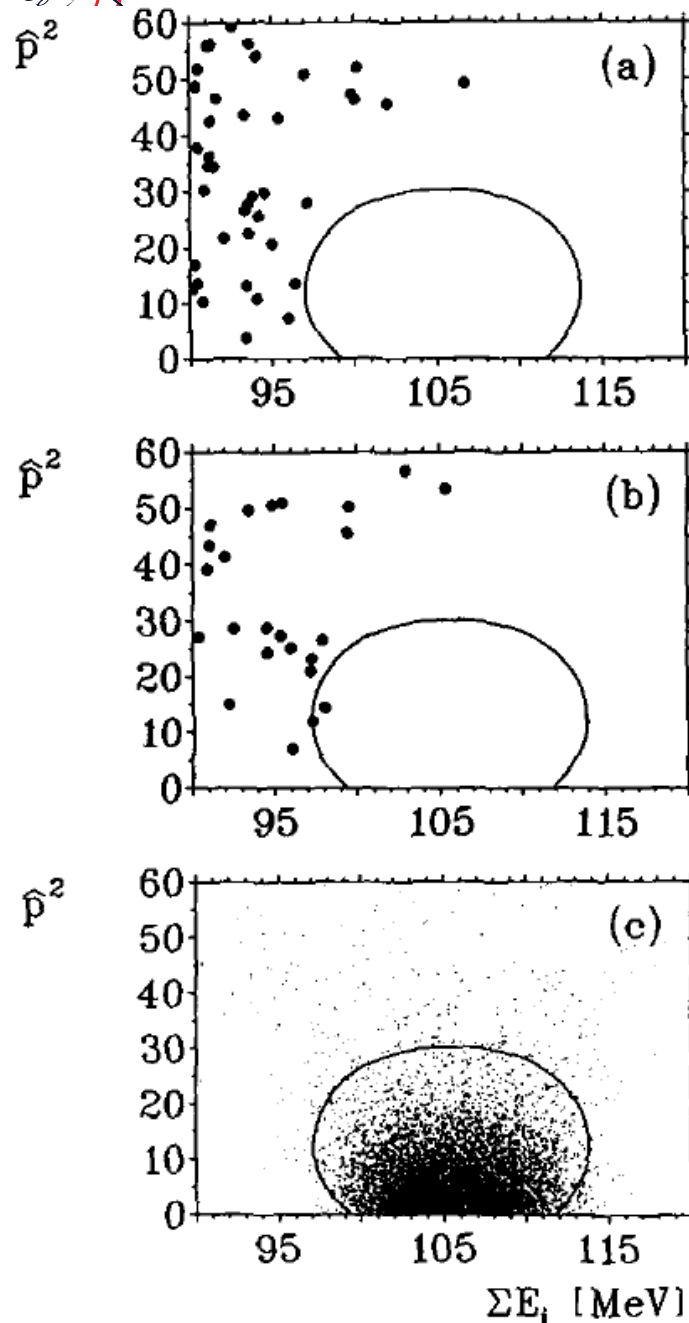
Data taking 1983 - 1986

Up to  $5 \times 10^6$   $\mu$  stops/s





# SINDRUM



Results:

(Resolution weighted momentum of the CMS system vs. sum of the three electron energies)

(a) Coincident events - 60% accidentals, 40% internal conversion

(b) Accidentals

(c) Signal MC with 95% contour

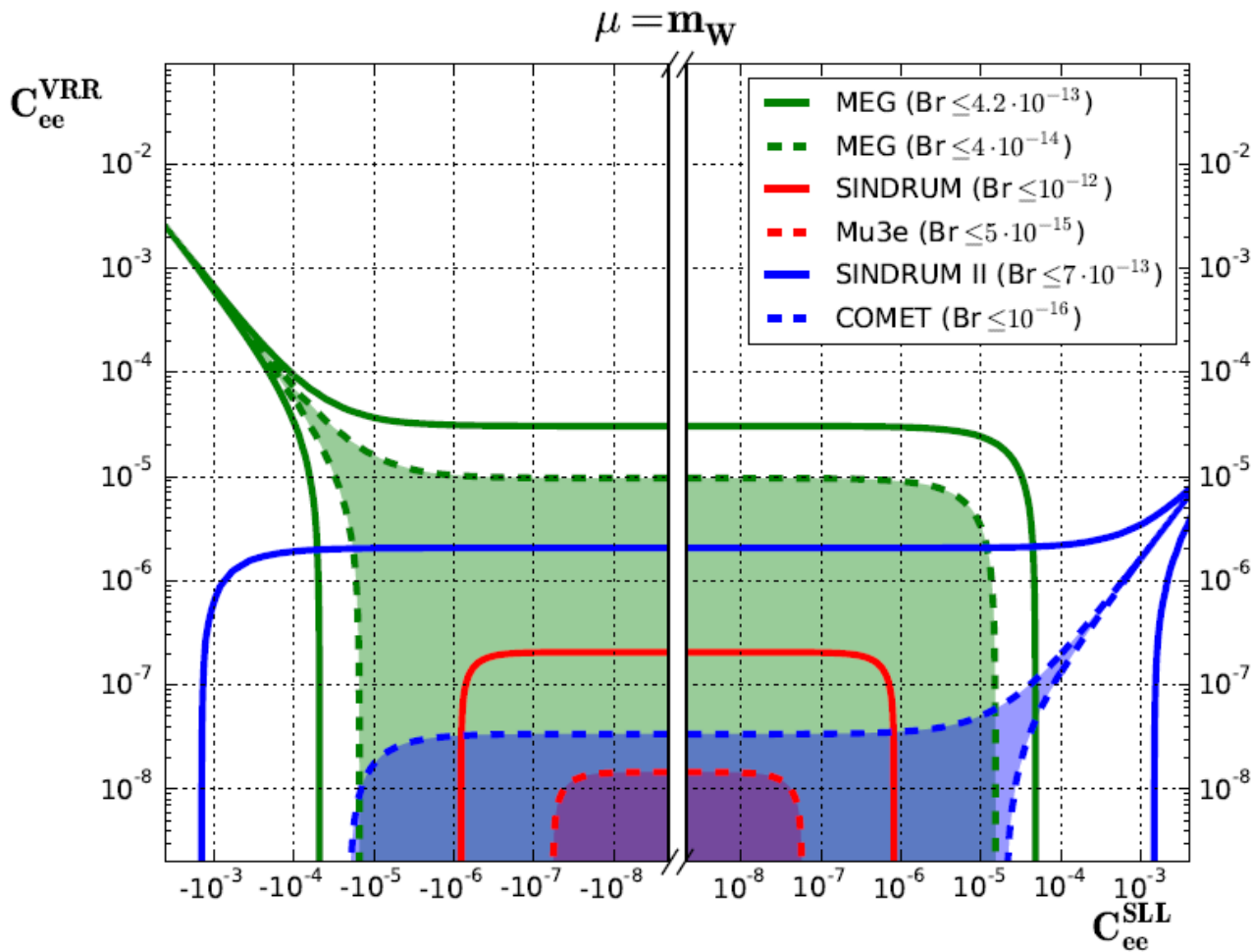
No events in signal area seen:

$$B(\mu^+ \rightarrow e^+e^-e^+) < 1.0 \cdot 10^{-12}$$

Probably some more potential in the apparatus, ultimately limited by rate capability and momentum resolution



# LFV Muon Decay in Effective Field Theory



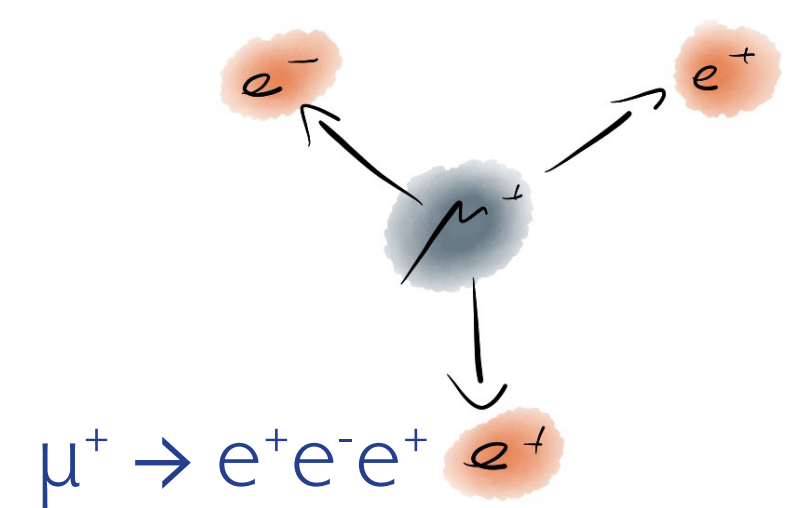
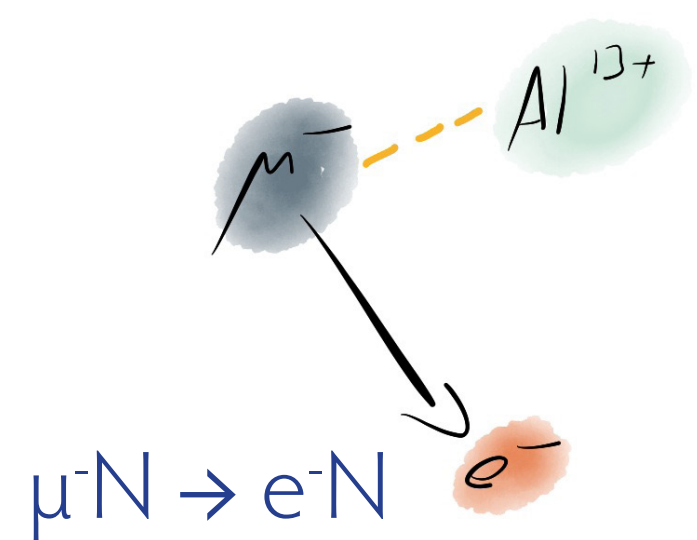
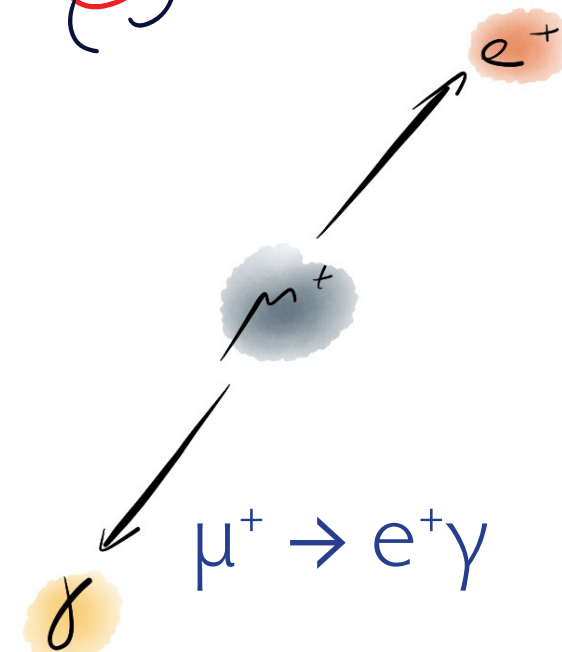
- Effective field theory approach with renormalisation group running
- Experiments put complementary constraints on Wilson coefficients

Renormalisation-group improved analysis of  $\mu \rightarrow e$  processes in a systematic effective-field-theory approach

A. Crivellin, S. Davidson, G. M. Pruna, A. Signer

e-Print: 1702.03020 [hep-ph] JHEP 05 (2017), 117

# LFV Muon Decays: Experimental signatures



## Kinematics

- 2-body decay
- Monoenergetic  $e^+$ ,  $\gamma$
- Back-to-back

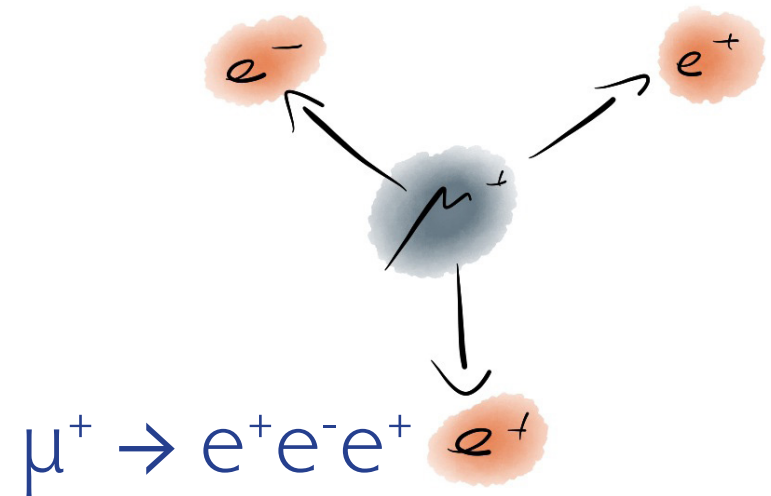
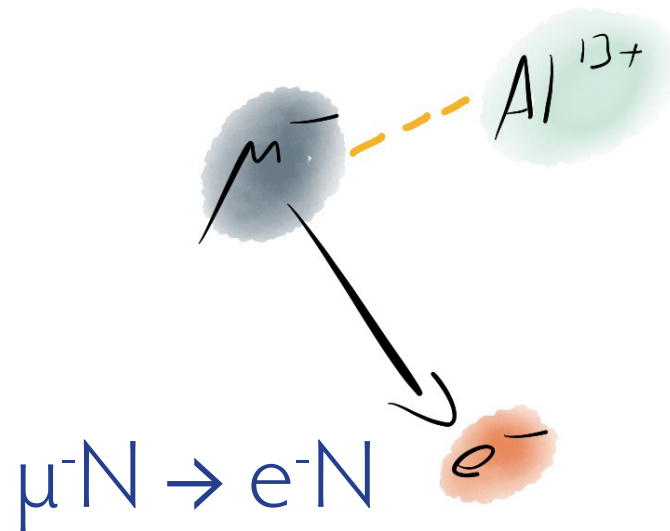
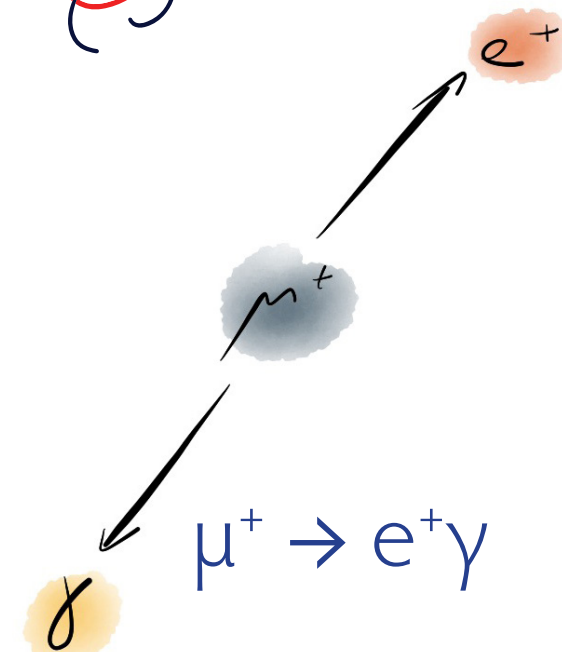
## Kinematics

- Quasi 2-body decay
- Monoenergetic  $e^-$
- Single particle detected

## Kinematics

- 3-body decay
- Invariant mass constraint
- $\sum p_i = 0$

# LFV Muon Decays: Experimental signatures



## Kinematics

- 2-body decay
- Monoenergetic  $e^+$ ,  $\gamma$
- Back-to-back

## Background

- Accidental background

## Kinematics

- Quasi 2-body decay
- Monoenergetic  $e^-$
- Single particle detected

## Background

- Decay in orbit
- Antiprotons, pions, cosmics

## Kinematics

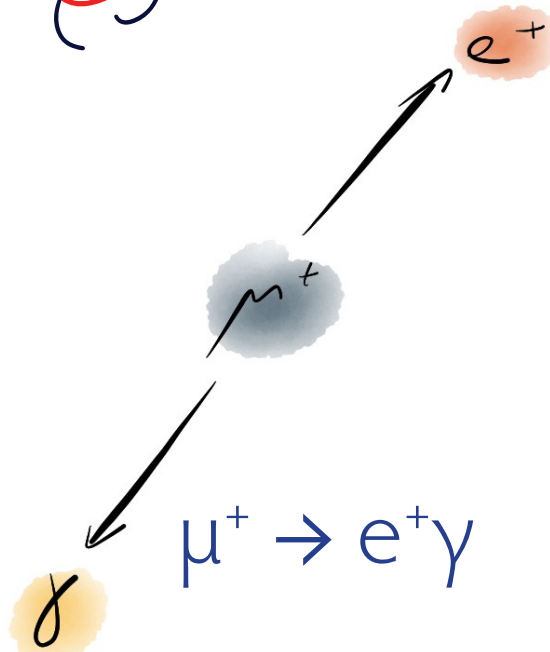
- 3-body decay
- Invariant mass constraint
- $\sum p_i = 0$

## Background

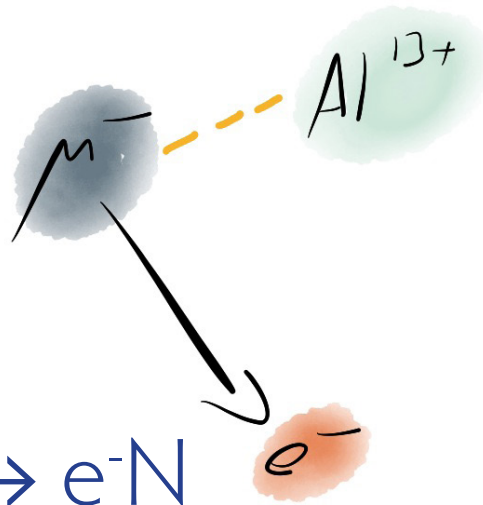
- Radiative decay
- Accidental background



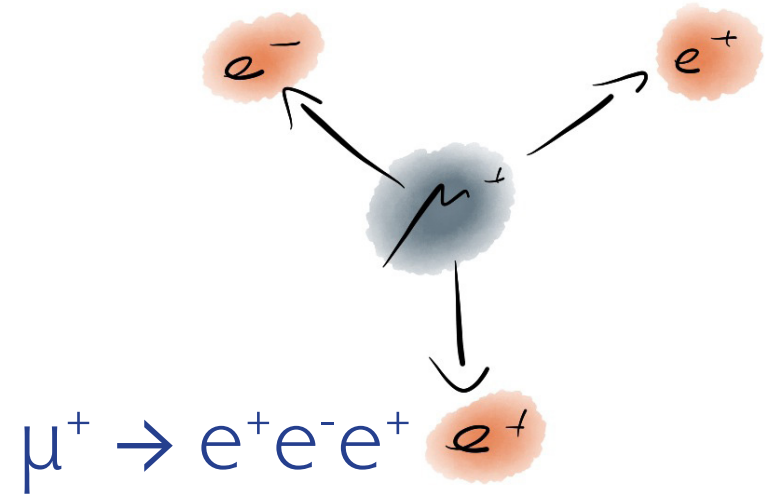
# LFV Muon Decays: Experimental signatures



$$\mu^+ \rightarrow e^+ \gamma$$



$$\mu^- N \rightarrow e^- N$$



$$\mu^+ \rightarrow e^+ e^- e^+$$

## Kinematics

- 2-body decay
- Monoenergetic
- Back-to-back

## Background

- Atomic background

Continuous Beam

## Kinematics

- Quasi 2-body decay
- Monoenergetic
- Single particle detected

## Background

- $\Gamma$  orbit
- Atomic protons, pions

Pulsed Beam

## Kinematics

- 3-body decay
- Invariant mass constraint
- $\sum p_i = 0$

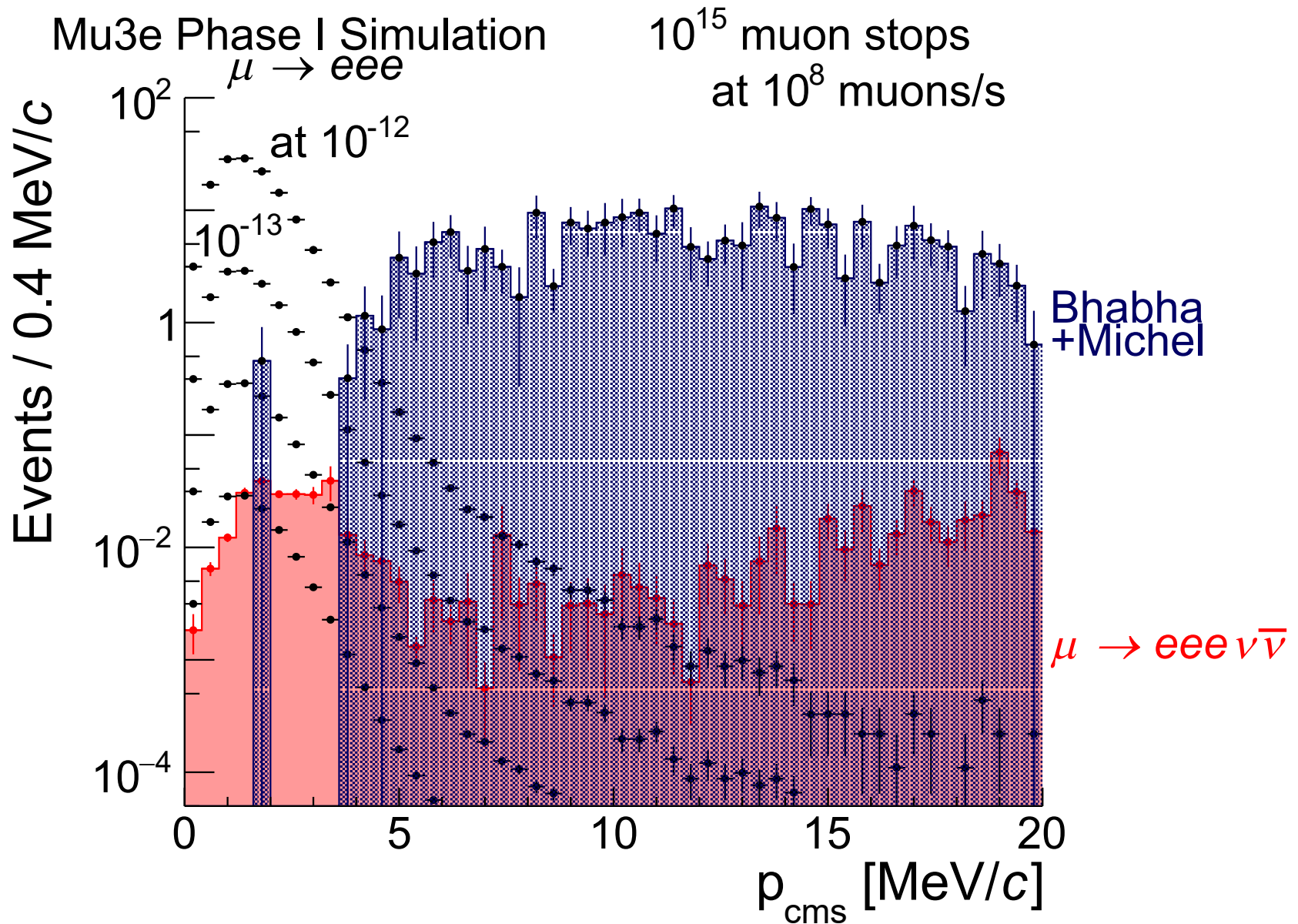
## Background

- Radiative decay
- Atomic background

Continuous Beam



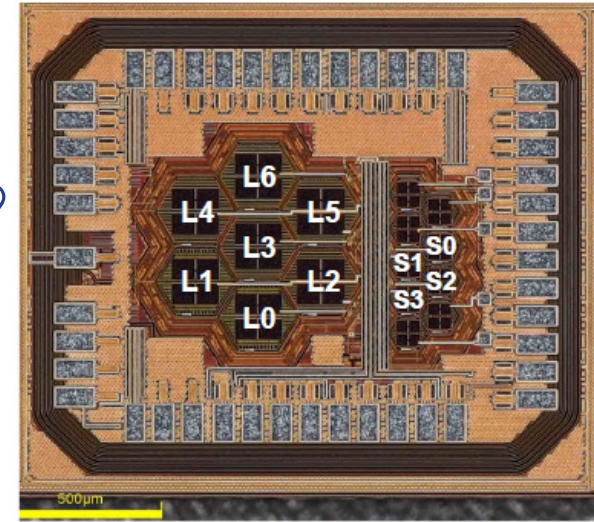
# Momentum distribution





# Phase II requirements and ideas

G. Iacobucci et al. 2019  
JINST 14 P11008



Better timing:

- Replace scintillating fibres by super-fast pixel detector  $O(100 \text{ ps})$  (SiGe, gain layer,...)
- Push HV-MAPS timing to  $O(1 \text{ ns})$

More acceptance, less material:

- Longer pixel modules
- Carbon fibre supports
- Serial powering
- Chip-to-chip communication
- ...

